

FEATURES

- **Sample Rate: 25Msps/10Msps**
- **81.6dB SNR and 100dB SFDR (2.5V Range)**
- **SFDR 90dB at 70MHz (1.667V_{P-P} Input Range)**
- **PGA Front End (2.5V_{P-P} or 1.667V_{P-P} Input Range)**
- **380MHz Full Power Bandwidth S/H**
- **Optional Internal Dither**
- **Optional Data Output Randomizer**
- **Single 3.3V Supply**
- **Power Dissipation: 220mW/140mW**
- **Clock Duty Cycle Stabilizer**
- **Out-of-Range Indicator**
- **Pin Compatible Family**
 - 25Msps: LTC2203 (16-Bit)
 - 10Msps: LTC2202 (16-Bit)
- **48-Pin (7mm × 7mm) QFN Package**

APPLICATIONS

- Telecommunications
- Receivers
- Cellular Base Stations
- Spectrum Analysis
- Imaging Systems
- ATE

DESCRIPTION

The LTC®2203/LTC2202 are 25Msps/10Msps, sampling 16-bit A/D converters designed for digitizing high frequency, wide dynamic range signals with input frequencies up to 380MHz. The input range of the ADC can be optimized with the PGA front end.

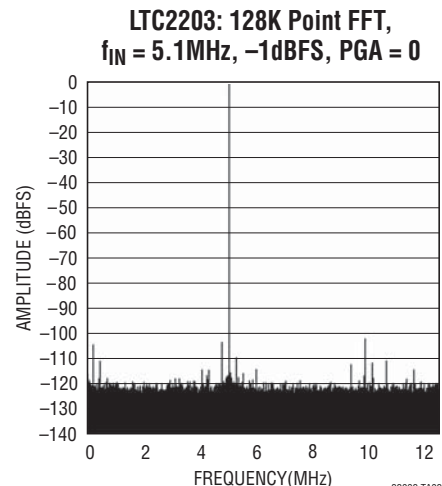
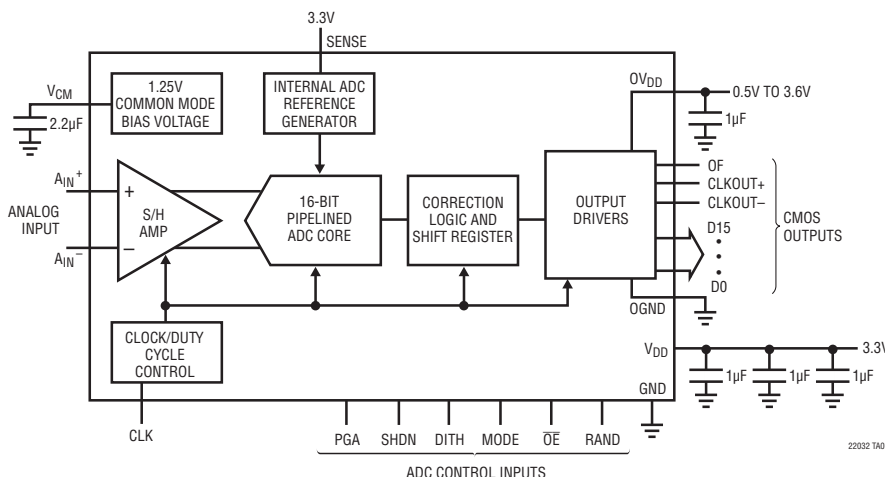
The LTC2203/LTC2202 are perfect for demanding applications, with AC performance that includes 81.6dB SNR and 100dB spurious free dynamic range (SFDR). Maximum DC specs include $\pm 4\text{LSB}$ INL, $\pm 1\text{LSB}$ DNL (no missing codes).

A separate output power supply allows the CMOS output swing to range from 0.5V to 3.6V.

A single-ended CLK input controls converter operation. An optional clock duty cycle stabilizer allows high performance at full speed with a wide range of clock duty cycles.

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TYPICAL APPLICATION



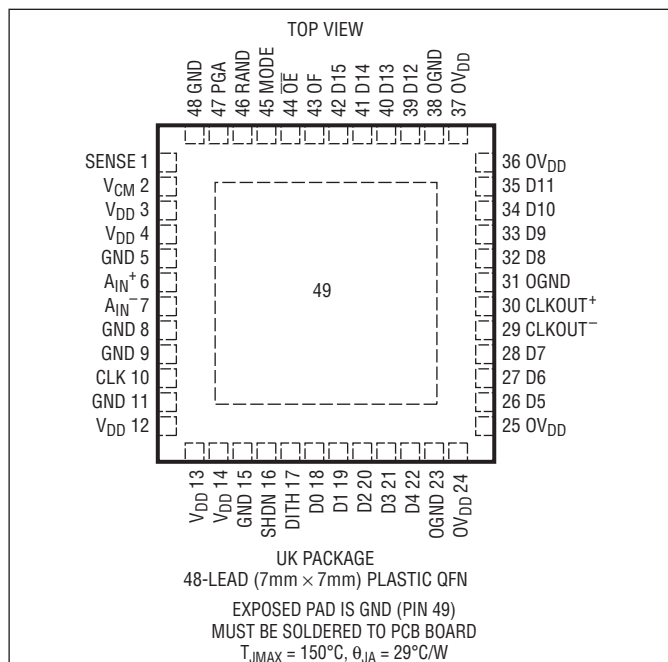
LTC2203/LTC2202

ABSOLUTE MAXIMUM RATINGS

$OV_{DD} = V_{DD}$ (Notes 1 and 2)

Supply Voltage (V_{DD}).....	–0.3V to 4V
Digital Output Supply Voltage (OV_{DD}).....	–0.3V to 4V
Digital Output Ground Voltage ($OGND$).....	–0.3V to 1V
Analog Input Voltage (Note 3)	–0.3V to ($V_{DD} + 0.3V$)
Digital Input Voltage	–0.3V to ($V_{DD} + 0.3V$)
Digital Output Voltage.....	–0.3V to ($OV_{DD} + 0.3V$)
Power Dissipation.....	2000mW
Operating Temperature Range	
LTC2203C/LTC2202C	0°C to 70°C
LTC2203I/LTC2202I.....	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC2203CUK#PBF	LTC2203CUK#TRPBF	LTC2203UK	48-Lead (7mm × 7mm) Plastic QFN	0°C to 70°C
LTC2202CUK#PBF	LTC2202CUK#TRPBF	LTC2202UK	48-Lead (7mm × 7mm) Plastic QFN	0°C to 70°C
LTC2203IUK#PBF	LTC2203IUK#TRPBF	LTC2203UK	48-Lead (7mm × 7mm) Plastic QFN	–40°C to 85°C
LTC2202IUK#PBF	LTC2202IUK#TRPBF	LTC2202UK	48-Lead (7mm × 7mm) Plastic QFN	–40°C to 85°C
LEAD BASED FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC2203CUK	LTC2203CUK#TR	LTC2203UK	48-Lead (7mm × 7mm) Plastic QFN	0°C to 70°C
LTC2202CUK	LTC2202CUK#TR	LTC2202UK	48-Lead (7mm × 7mm) Plastic QFN	0°C to 70°C
LTC2203IUK	LTC2203IUK#TR	LTC2203UK	48-Lead (7mm × 7mm) Plastic QFN	–40°C to 85°C
LTC2202IUK	LTC2202IUK#TR	LTC2202UK	48-Lead (7mm × 7mm) Plastic QFN	–40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandreel/>

CONVERTER CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 4)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Resolution (No missing codes)		16			
Integral Linearity Error	Differential Analog Input (Note 5) $T_A = 25^\circ\text{C}$		± 1.2	± 4.0	LSB
Integral Linearity Error	Differential Analog Input (Note 5)	●	± 1.5	± 4.5	LSB
Differential Linearity Error	Differential Analog Input	●	± 0.3	± 1	LSB
Offset Error	(Note 6)	●	± 2	± 10	mV
Offset Drift			± 10		$\mu\text{V}/^\circ\text{C}$
Gain Error	External Reference	●	± 0.2	± 1.5	%FS
Full-Scale Drift	Internal Reference External Reference		± 30 ± 15		ppm/ $^\circ\text{C}$ ppm/ $^\circ\text{C}$
Transition Noise	External Reference (2.5V Range, PGA = 0)		1.92		LSB _{RMS}

ANALOG INPUT

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{IN}	Analog Input Range (A _{IN} ⁺ – A _{IN} [–])	3.135V ≤ V _{DD} ≤ 3.465V		1.667 or 2.5			V _{P-P}
V _{IN, CM}	Analog Input Common Mode	Differential Input (Note 7)	●	1	1.25	1.5	V
I _{IN}	Analog Input Leakage Current	0V ≤ A _{IN} ⁺ , A _{IN} [–] ≤ V _{DD} (Note 9)	●	–1		1	μA
I _{SENSE}	SENSE Input Leakage Current	0V ≤ SENSE ≤ V _{DD} (Note 10)	●	–3		3	μA
I _{MODE}	MODE Pin Pull-Down Current to GND			10			μA
I _{OE}	OE Pin Pull-Down Current to GND			10			μA
C _{IN}	Analog Input Capacitance	Sample Mode CLK = 0 Hold Mode CLK = 0		10.5 1.4			pF pF
t _{AP}	Sample-and-Hold Acquisition Delay Time			0.9			ns
t _{JITTER}	Sample-and-Hold Acquisition Delay Time Jitter			200			f _{SRMS}
CMRR	Analog Input Common Mode Rejection Ratio	1V < (A _{IN} ⁺ = A _{IN} [–]) <1.5V		80			dB
BW-3dB	Full Power Bandwidth	Rs < 20Ω		380			MHz

DYNAMIC ACCURACY

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $A_{IN} = -1\text{dBFS}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS	MIN	LTC2203 TYP	MAX	MIN	LTC2202 TYP	MAX	UNITS
SNR	Signal-to-Noise Ratio	1MHz Input (2.25V Range, PGA = 0)		81.6			81.6		dBFS
		1MHz Input (1.667V Range, PGA = 1)		79.4			79.4		dBFS
		5MHz Input (2.5V Range, PGA = 0)	●	80	81.6	80	81.6		dBFS
		5MHz Input (1.667V Range, PGA = 1)			79.4		79.4		dBFS
		12.5MHz Input (2.5V Range, PGA = 0)		81.4			81.4		dBFS
		12.5MHz Input (1.667V Range, PGA = 1)		79.3			79.3		dBFS
		30MHz Input (2.5V Range, PGA = 0)		80.8			80.8		dBFS
		30MHz Input (1.667V Range, PGA = 1)	●	77.5	78.9	77.5	78.9		dBFS
		70MHz Input (2.5V Range, PGA = 0)		78.3			78.3		dBFS
		70MHz Input (1.667V Range, PGA = 1)		77.2			77.2		dBFS

DYNAMIC ACCURACY

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $A_{IN} = -1\text{dBFS}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS	LTC2203			LTC2202			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
SFDR	Spurious Free Dynamic Range 2 nd or 3 rd Harmonic	1MHz Input (2.5V Range, PGA = 0)		100			100		dBc
		1MHz Input (1.667V Range, PGA = 1)		100			100		dBc
		5MHz Input (2.5V Range, PGA = 0)	●	85	100	85	100		dBc
		5MHz Input (2.5V Range, PGA = 0)		87	100	87	100		dBc
		5MHz Input (1.667V Range, PGA = 1)			100		100		dBc
		12.5MHz Input (2.5V Range, PGA = 0)		95			95		dBc
		12.5MHz Input (1.667V Range, PGA = 1)			100		100		dBc
		30MHz Input (2.5V Range, PGA = 0)		90			90		dBc
		30MHz Input (1.667V Range, PGA = 1)	●	85	95	85	95		dBc
		70MHz Input (2.5V Range, PGA = 0)		85			85		dBc
		70MHz Input (1.667V Range, PGA = 1)		90			90		dBc
SFDR	Spurious Free Dynamic Range 4th Harmonic or Higher	1MHz Input (2.5V Range, PGA = 0)		100			100		dBc
		1MHz Input (1.667V Range, PGA = 1)		100			100		dBc
		5MHz Input (2.5V Range, PGA = 0)	●	90	100	90	100		dBc
		5MHz Input (1.667V Range, PGA = 1)			100		100		dBc
		12.5MHz Input (2.5V Range, PGA = 0)		100			100		dBc
		12.5MHz Input (1.667V Range, PGA = 1)		100			100		dBc
		30MHz Input (2.5V Range, PGA = 0)		100			100		dBc
		30MHz Input (1.667V Range, PGA = 1)	●	90	100	90	100		dBc
		70MHz Input (2.5V Range, PGA = 0)		90			90		dBc
		70MHz Input (1.667V Range, PGA = 1)		90			90		dBc
S/(N+D)	Signal-to-Noise Plus Distortion Ratio	1MHz Input (2.5V Range, PGA = 0)		81.5			81.5		dBFS
		1MHz Input (1.667V Range, PGA = 1)		79.3			79.3		dBFS
		5MHz Input (2.5V Range, PGA = 0)	●	79.7	81.5	79.7	81.5		dBFS
		5MHz Input (1.667V Range, PGA = 1)			79.3		79.3		dBFS
		12.5MHz Input (2.5V Range, PGA = 0)		81.3			81.3		dBFS
		12.5MHz Input (1.667V Range, PGA = 1)		79.2			79.2		dBFS
		30MHz Input (2.5V Range, PGA = 0)		80.6			80.6		dBFS
		30MHz Input (1.667V Range, PGA = 1)	●	77.2	78.6	77.2	78.6		dBFS
		70MHz Input (2.5V Range, PGA = 0)		78.1			78.1		dBFS
		70MHz Input (1.667V Range, PGA = 1)		77			77		dBFS
SFDR	Spurious Free Dynamic Range at -25dBFS Dither "OFF"	1MHz Input (2.5V Range, PGA = 0)		105			105		dBFS
		1MHz Input (1.667V Range, PGA = 1)		105			105		dBFS
		5MHz Input (2.5V Range, PGA = 0)		105			105		dBFS
		5MHz Input (1.667V Range, PGA = 1)		105			105		dBFS
		12.5MHz Input (2.5V Range, PGA = 0)		105			105		dBFS
		12.5MHz Input (1.667V Range, PGA = 1)		105			105		dBFS
		30MHz Input (2.5V Range, PGA = 0)		105			105		dBFS
		30MHz Input (1.667V Range, PGA = 1)		105			105		dBFS
		70MHz Input (2.5V Range, PGA = 0)		100			100		dBFS
		70MHz Input (1.667V Range, PGA = 1)		100			100		dBFS

DYNAMIC ACCURACY

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $A_{IN} = -1\text{dBFS}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS	LTC2203			LTC2202			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
SFDR	Spurious Free Dynamic Range at -25dBFS Dither "ON"	1MHz Input (2.5V Range, PGA = 0)		115			115		dBFS
		1MHz Input (1.667V Range, PGA = 1)		115			115		dBFS
		5MHz Input (2.5V Range, PGA = 0)	● 100	115		100	115		dBFS
		5MHz Input (1.667V Range, PGA = 1)		115			115		dBFS
		12.5MHz Input (2.5V Range, PGA = 0)		115			115		dBFS
		12.5MHz Input (1.667V Range, PGA = 1)		115			115		dBFS
		30MHz Input (2.5V Range, PGA = 0)		115			115		dBFS
		30MHz Input (1.667V Range, PGA = 1)		115			115		dBFS
		70MHz Input (2.5V Range, PGA = 0)		110			110		dBFS
		70MHz Input (1.667V Range, PGA = 1)		110			110		dBFS

COMMON MODE BIAS CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 4)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{CM} Output Voltage	$I_{OUT} = 0$	1.15	1.25	1.35	V
V_{CM} Output Tempco	$I_{OUT} = 0$		± 40		ppm/ $^\circ\text{C}$
V_{CM} Line Regulation	$3.135\text{V} \leq V_{DD} \leq 3.465\text{V}$		1		mV/V
V_{CM} Output Resistance	$1\text{mA} \leq I_{OUT} \leq 1\text{mA}$		2		Ω

DIGITAL INPUTS AND DIGITAL OUTPUTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS (CLK, $\overline{\text{OE}}$, DITH, PGA, SHDN, RAND)						
V_{IH}	High Level Input Voltage	$V_{DD} = 3.3\text{V}$	● 2			V
V_{IL}	Low Level Input Voltage	$V_{DD} = 3.3\text{V}$	●		0.8	V
I_{IN}	Digital Input Current	$V_{IN} = 0\text{V}$ to V_{DD}	●		± 10	μA
C_{IN}	Digital Input Capacitance	(Note 7)		1.5		pF

LOGIC OUTPUTS **$OV_{DD} = 3.3\text{V}$**

V_{OH}	High Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = -10\mu\text{A}$ $I_O = -200\mu\text{A}$	● 3.1	3.299 3.29	V V
V_{OL}	Low Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = 160\mu\text{A}$ $I_O = 1.6\text{mA}$	●	0.01 0.10	V 0.4
I_{SOURCE}	Output Source Current	$V_{OUT} = 0\text{V}$			-50	mA
I_{SINK}	Output Sink Current	$V_{OUT} = 3.3\text{V}$			50	mA

 $OV_{DD} = 2.5\text{V}$

V_{OH}	High Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = -200\mu\text{A}$		2.49	V
V_{OL}	Low Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = 1.60\text{mA}$		0.1	V

 $OV_{DD} = 1.8\text{V}$

V_{OH}	High Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = -200\mu\text{A}$		1.79	V
V_{OL}	Low Level Output Voltage	$V_{DD} = 3.3\text{V}$	$I_O = 1.60\text{mA}$		0.1	V

POWER REQUIREMENTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $A_{IN} = -1\text{dBFS}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS		LTC2203			LTC2202			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{DD}	Analog Supply Voltage		●	3.135	3.3	3.465	3.135	3.3	3.465	V
P_{SHDN}	Shutdown Power	$SHDN = V_{DD}$, $CLK = V_{DD}$			2			2		mW
OV_{DD}	Output Supply Voltage		●	0.5		3.6	0.5		3.6	V
I_{VDD}	Analog Supply Current		●		66	80		42	50	mA
P_{DIS}	Power Dissipation		●		220	264		140	165	mW

TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 4)

SYMBOL	PARAMETER	CONDITIONS		LTC2203			LTC2202			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
f_S	Sampling Frequency		●	1		25	1		10	MHz
t_L	CLK Low Time	Duty Cycle Stabilizer Off	●	18.9	20	500	40	50	500	ns
		Duty Cycle Stabilizer On	●	5	20	500	5	50	500	ns
t_H	CLK High Time	Duty Cycle Stabilizer Off	●	18.9	20	500	40	50	500	ns
		Duty Cycle Stabilizer On	●	5	20	500	5	50	500	ns
t_{AP}	Sample-and-Hold Aperture Delay				0.9			0.9		ns
t_D	CLK to DATA Delay	$C_L = 5\text{pF}$ (Note 7)	●	1.3	3.1	4.9	1.3	3.1	4.9	ns
t_C	CLK to CLKOUT Delay	$C_L = 5\text{pF}$ (Note 7)	●	1.3	3.1	4.9	1.3	3.1	4.9	ns
t_{SKEW}	DATA to CLKOUT Skew	$C_L = 5\text{pF}$ (Note 7)	●	-0.6	0	0.6	-0.6	0	0.6	ns
	DATA Access Time	$C_L = 5\text{pF}$ (Note 7)	●		5	15		5	15	ns
	Bus Relinquish Time	(Note 7)	●		5	15		5	15	ns
Pipeline Latency					7			7		Cycles

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: All voltage values are with respect to GND, with GND and OGND shorted (unless otherwise noted).

Note 3: When these pin voltages are taken below GND or above V_{DD} , they will be clamped by internal diodes. This product can handle input currents of greater than 100mA below GND or above V_{DD} without latchup.

Note 4: $V_{DD} = 3.3\text{V}$, $f_{SAMPLE} = 25\text{MHz}$ (LTC2203), 10MHz (LTC2202), input range = $2.5V_{P-P}$ with differential drive ($PGA = 0$), unless otherwise specified.

Note 5: Integral nonlinearity is defined as the deviation of a code from a "best fit straight line" to the transfer curve. The deviation is measured from the center of the quantization band.

Note 6: Offset error is the offset voltage measured from $-1/2\text{LSB}$ when the output code flickers between 0000 0000 0000 0000 and 1111 1111 1111 1111 in 2's complement output mode.

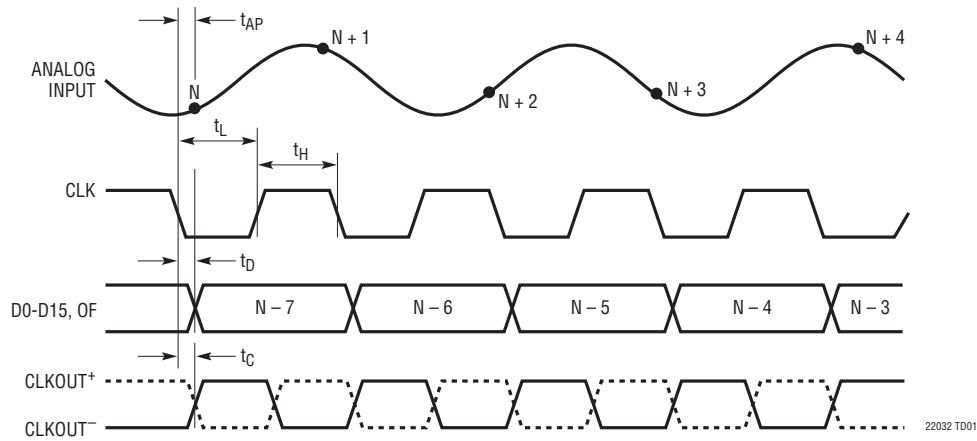
Note 7: Guaranteed by design, not subject to test.

Note 8: Recommended operating conditions.

Note 9: Dynamic current from switched capacitor inputs is large compared to DC leakage current, and will vary with sample rate.

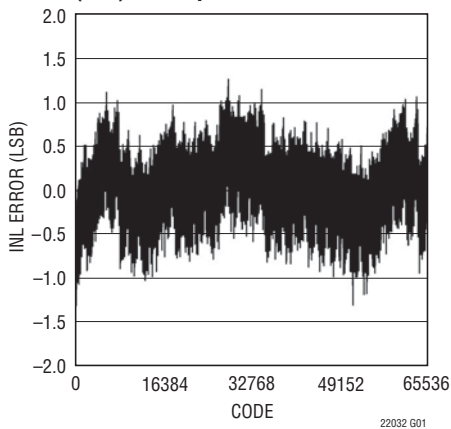
Note 10: Leakage current will experience transient at power up. Keep resistance $< 1\text{K}\Omega$.

TIMING DIAGRAM

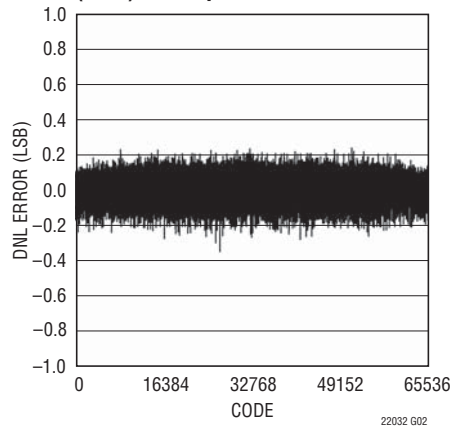


TYPICAL PERFORMANCE CHARACTERISTICS

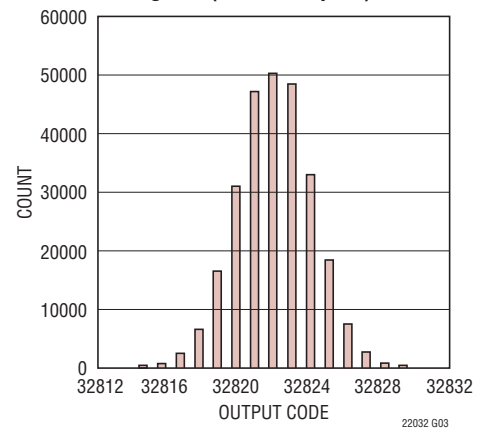
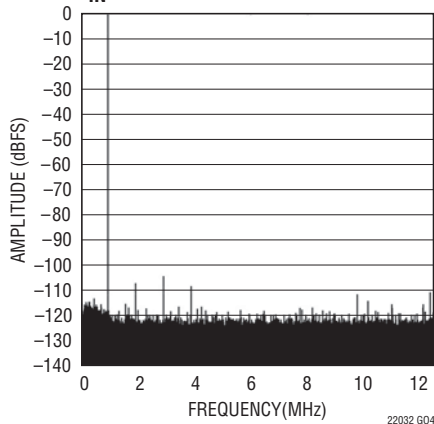
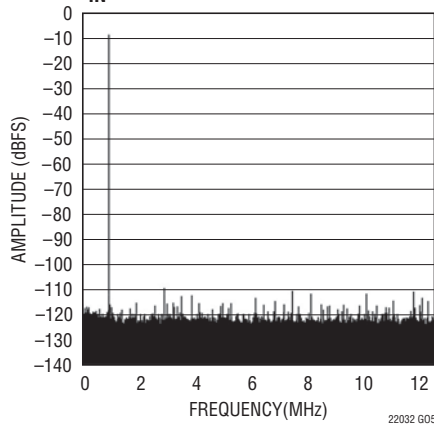
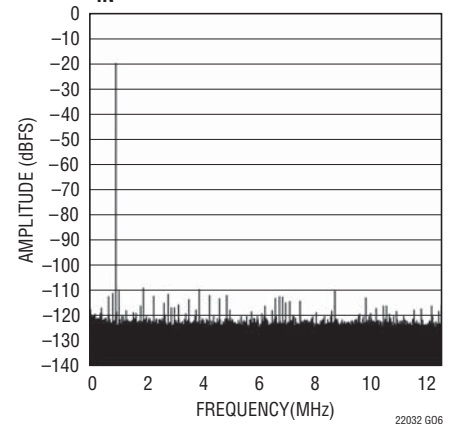
LTC2203: Integral Nonlinearity (INL) vs Output Code



LTC2203: Differential Nonlinearity (DNL) vs Output Code



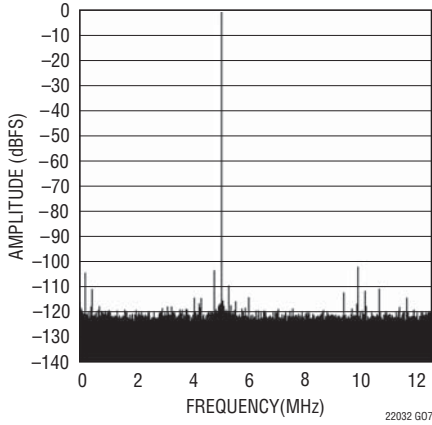
LTC2203: AC Grounded Input Histogram (256k Samples)

LTC2203: 128K Point FFT, $f_{IN} = 1\text{MHz}$, -1dBFS , $\text{PGA} = 0$ LTC2203: 128K Point FFT, $f_{IN} = 1\text{MHz}$, -10dBFS , $\text{PGA} = 0$ LTC2203: 128K Point FFT, $f_{IN} = 1\text{MHz}$, -20dBFS , $\text{PGA} = 0$ 

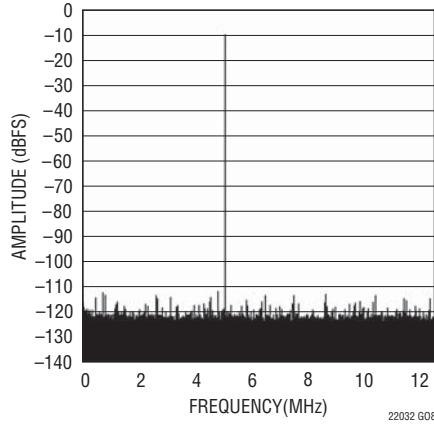
22032fd

TYPICAL PERFORMANCE CHARACTERISTICS

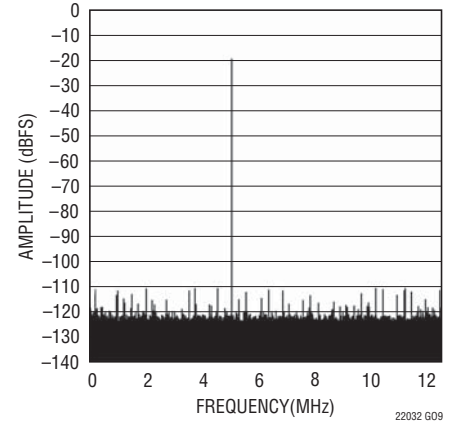
**LTC2203: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -1dBFS , $\text{PGA} = 0$**



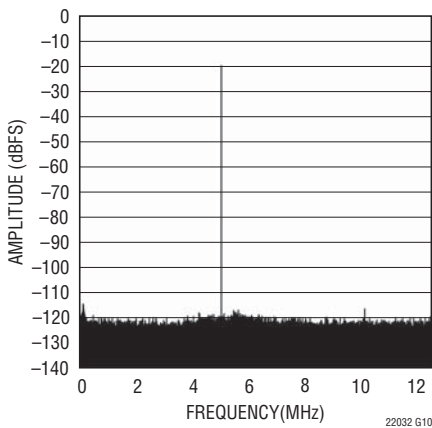
**LTC2203: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -10dBFS , $\text{PGA} = 0$**



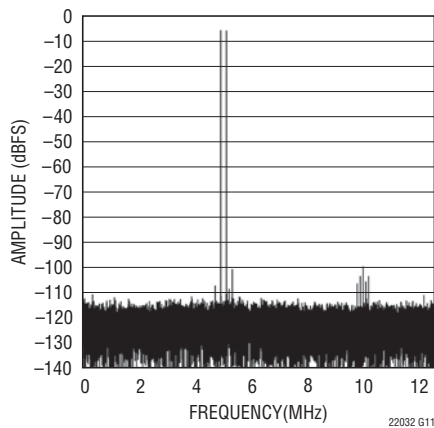
**LTC2203: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -20dBFS , $\text{PGA} = 0$,
Internal Dither "Off"**



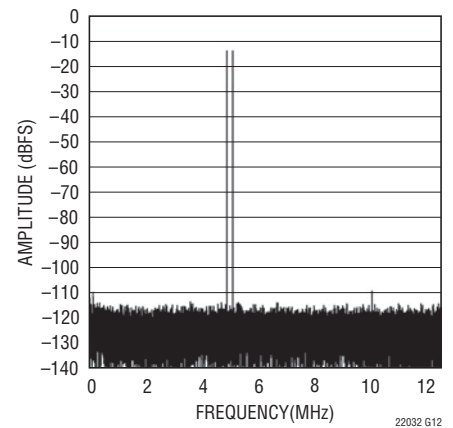
**LTC2203: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -20dBFS , $\text{PGA} = 0$,
Internal Dither "On"**



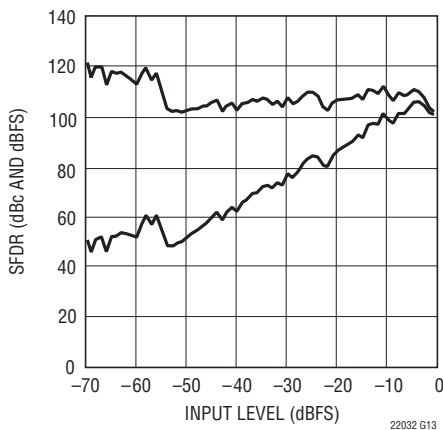
**LTC2203: 32K Point 2-Tone FFT,
 $f_{IN} = 4.9\text{MHz}$ and 30.1MHz ,
 -7dBFS , $\text{PGA} = 0$**



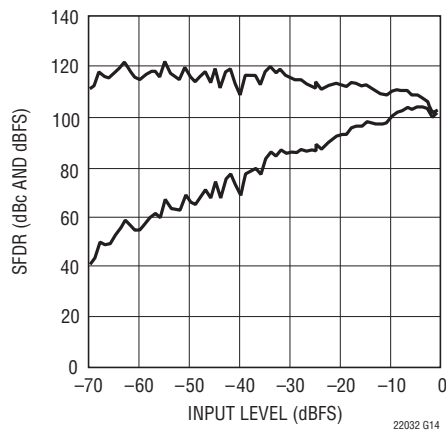
**LTC2203: 32K Point 2-Tone FFT,
 $f_{IN} = 4.9\text{MHz}$ and 30.1MHz ,
 -15dBFS , $\text{PGA} = 0$**



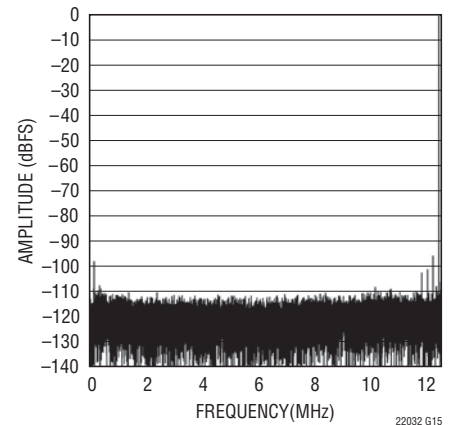
**LTC2203: SFDR vs Input Level,
 $f_{IN} = 5\text{MHz}$, $\text{PGA} = 0$, Dither "Off"**



**LTC2203: SFDR vs Input Level,
 $f_{IN} = 5\text{MHz}$, $\text{PGA} = 0$, Dither "On"**

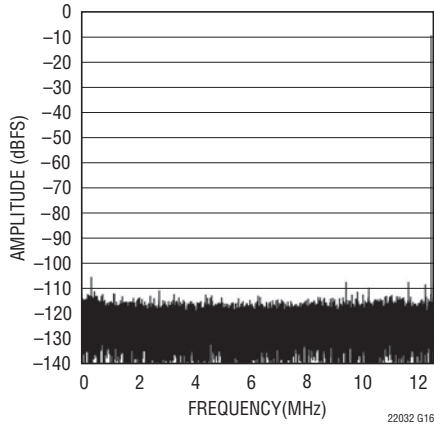


**LTC2203: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -1dBFS , $\text{PGA} = 0$**

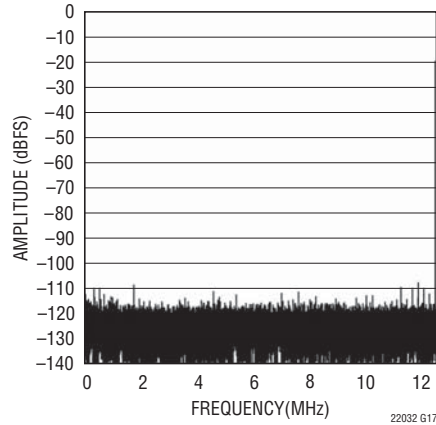


TYPICAL PERFORMANCE CHARACTERISTICS

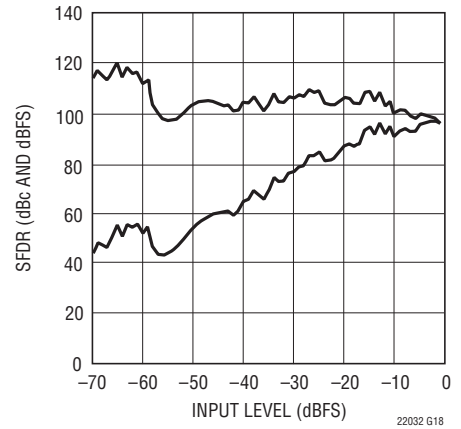
LTC2203: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -10dBFS , $\text{PGA} = 0$



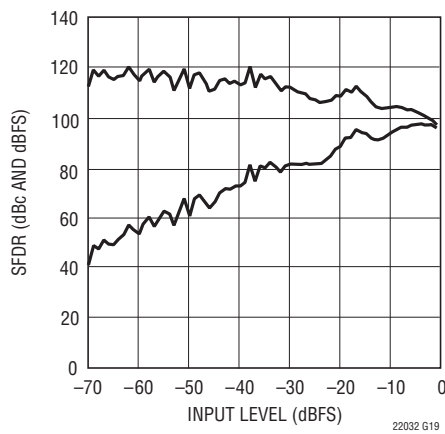
LTC2203: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -20dBFS , $\text{PGA} = 0$



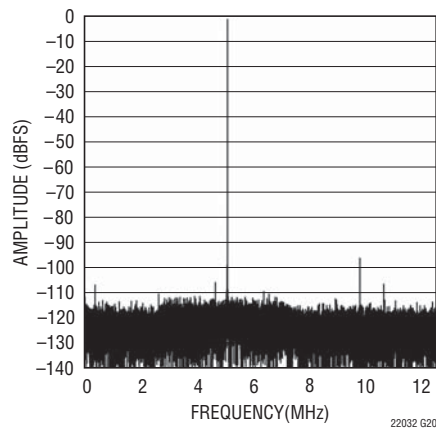
LTC2203: SFDR vs Input Level,
 $f_{IN} = 12.7\text{MHz}$, $\text{PGA} = 0$,
 Dither "Off"



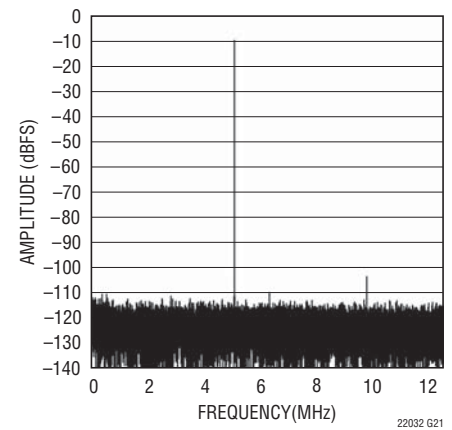
LTC2203: SFDR vs Input Level,
 $f_{IN} = 12.7\text{MHz}$, $\text{PGA} = 0$,
 Dither "On"



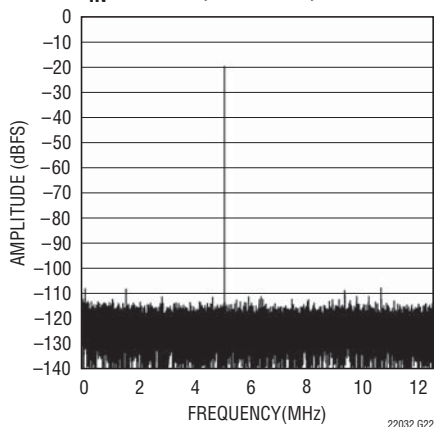
LTC2203: 32K Point FFT,
 $f_{IN} = 30\text{MHz}$, -1dBFS , $\text{PGA} = 1$



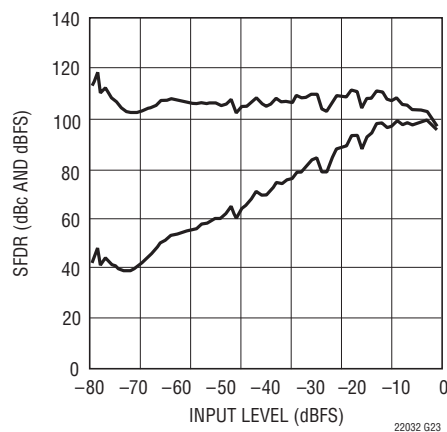
LTC2203: 32K Point FFT,
 $f_{IN} = 30\text{MHz}$, -10dBFS , $\text{PGA} = 1$



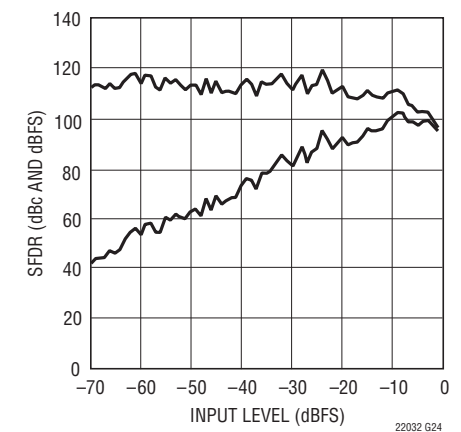
LTC2203: 32K Point FFT,
 $f_{IN} = 30\text{MHz}$, -20dBFS , $\text{PGA} = 1$



LTC2203: SFDR vs Input Level,
 $f_{IN} = 30.1\text{MHz}$, $\text{PGA} = 0$,
 Dither "Off"

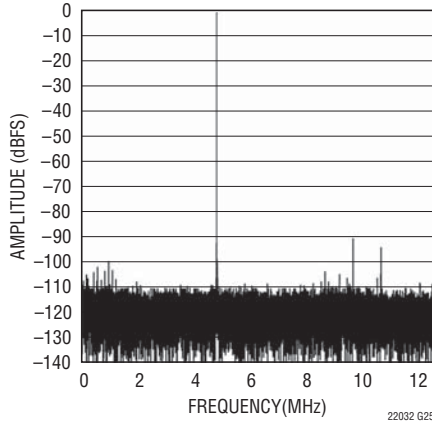


LTC2203: SFDR vs Input Level,
 $f_{IN} = 30.1\text{MHz}$, $\text{PGA} = 0$,
 Dither "On"

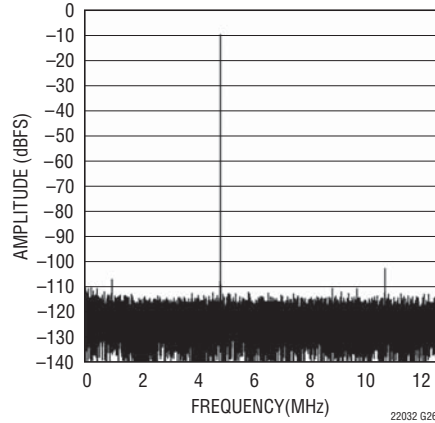


TYPICAL PERFORMANCE CHARACTERISTICS

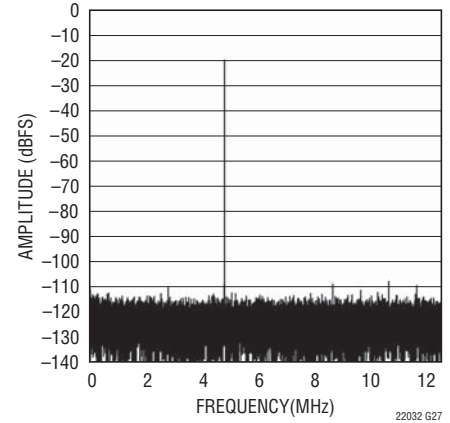
LTC2203: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -1dBFS , $\text{PGA} = 1$



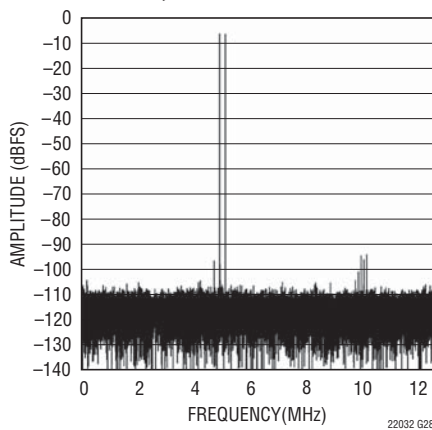
LTC2203: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -10dBFS , $\text{PGA} = 1$



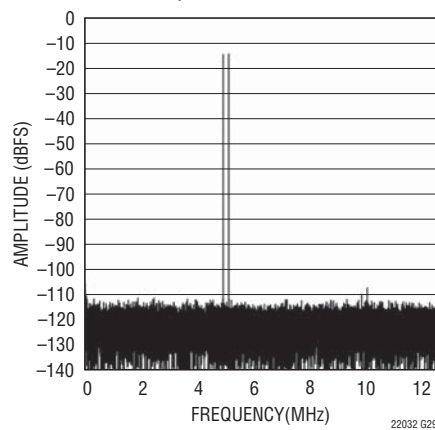
LTC2203: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -20dBFS , $\text{PGA} = 1$



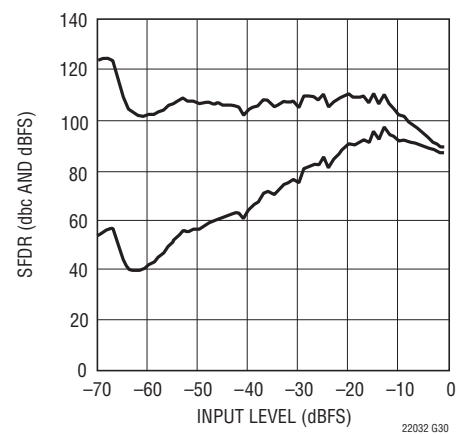
LTC2203: 32K Point 2-Tone FFT,
 $f_{IN} = 44.9\text{MHz}$ and 70.1MHz ,
 -7dBFS , $\text{PGA} = 0$



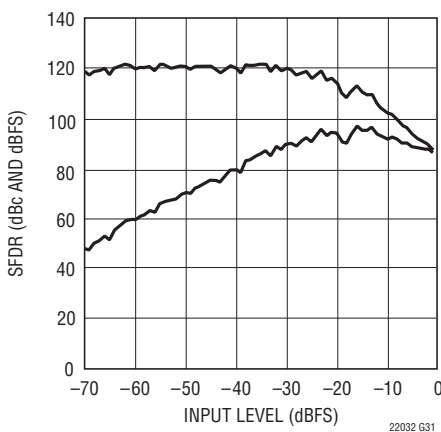
LTC2203: 32K Point 2-Tone FFT,
 $f_{IN} = 44.9\text{MHz}$ and 70.1MHz ,
 -15dBFS , $\text{PGA} = 0$



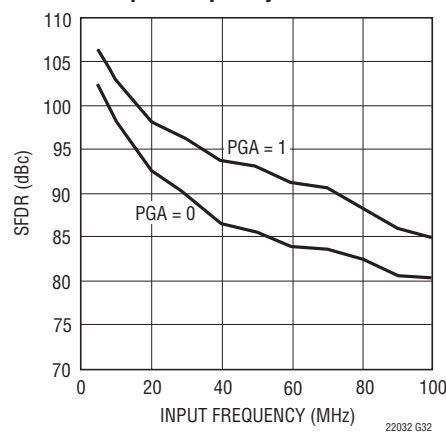
LTC2203: SFDR vs Input Level,
 $f_{IN} = 70.1\text{MHz}$, $\text{PGA} = 0$,
Dither "Off"



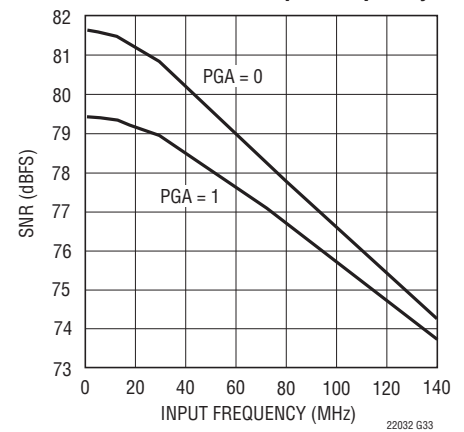
LTC2203: SFDR vs Input Level,
 $f_{IN} = 70.1\text{MHz}$, $\text{PGA} = 0$,
Dither "On"



LTC2203: SFDR (HD2 or HD3)
vs Input Frequency

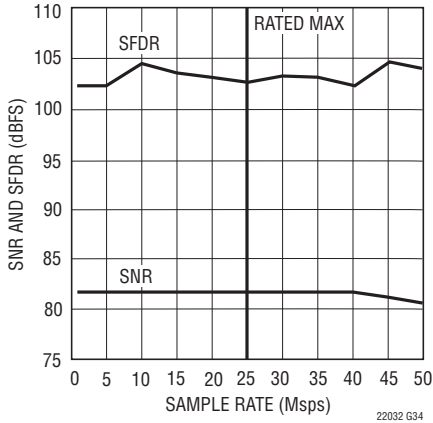
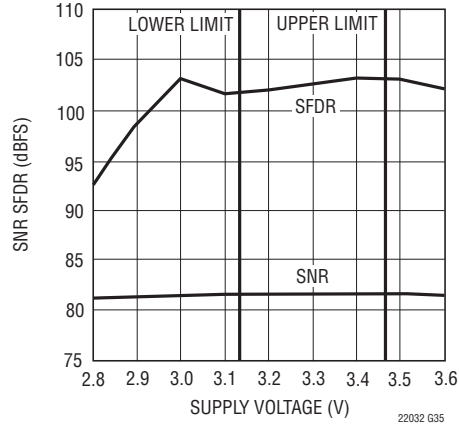
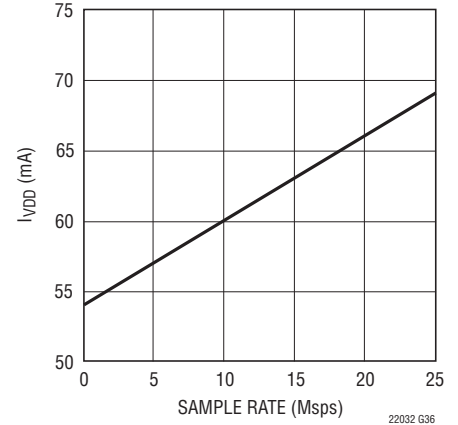


LTC2203: SNR vs Input Frequency

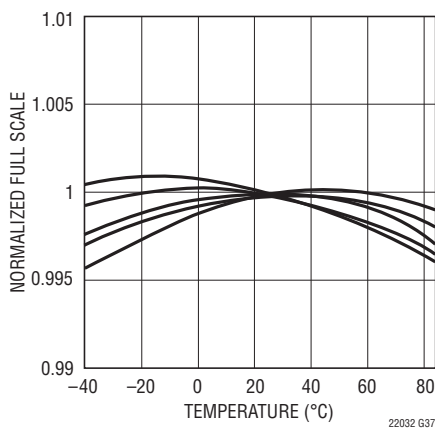


TYPICAL PERFORMANCE CHARACTERISTICS

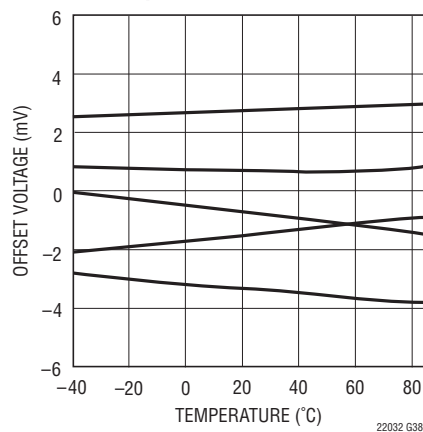
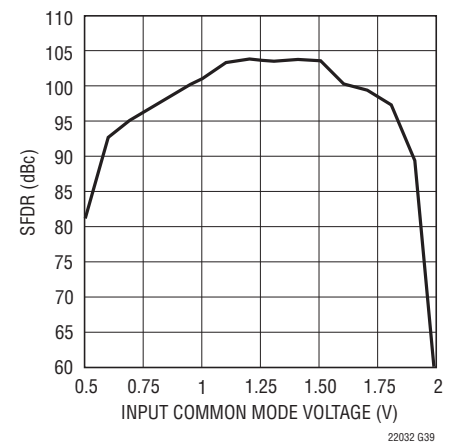
LTC2203: SNR and SFDR vs Sample Rate

LTC2203: SNR and SFDR vs Supply Voltage (V_{DD}), $f_{IN} = 5\text{MHz}$ LTC2203: I_{VDD} vs Sample Rate, 5MHz Sine Wave, -1dBFS

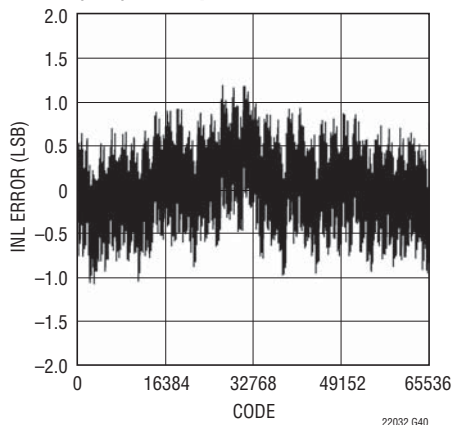
LTC2203: Normalized Full Scale vs Temperature, Internal Reference, 5 Units



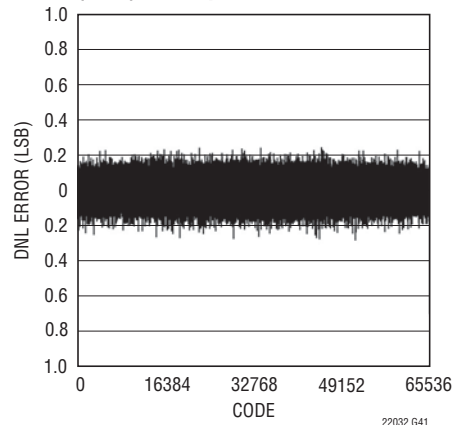
LTC2203: Offset Voltage vs Temperature, 5 Units

LTC2203: SFDR vs Input Common Mode Voltage, $f_{IN} = 5\text{MHz}$, -1dBFS, PGA = 0

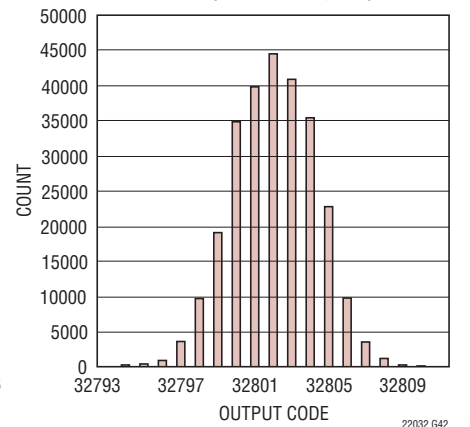
LTC2202: Integral Nonlinearity (INL) vs Output Code



LTC2202: Differential Nonlinearity (DNL) vs Output Code

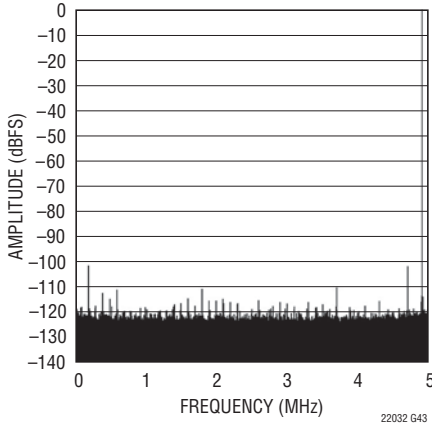


LTC2202: AC Grounded Input Histogram (256K Samples)

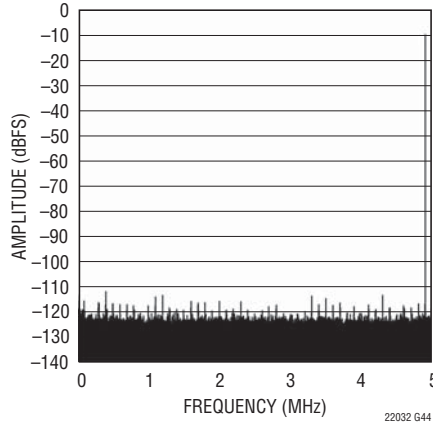


TYPICAL PERFORMANCE CHARACTERISTICS

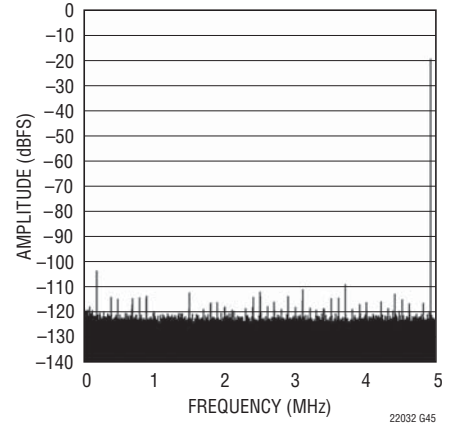
**LTC2202: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -1dBFS , PGA = 0**



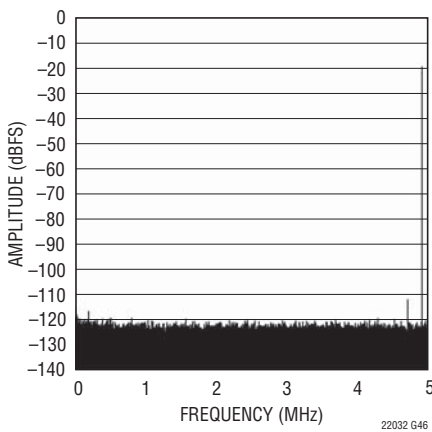
**LTC2202: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -10dBFS , PGA = 0**



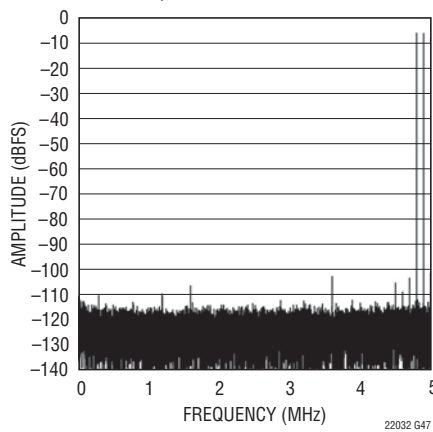
**LTC2202: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -20dBFS , PGA = 0,
Internal Dither "Off"**



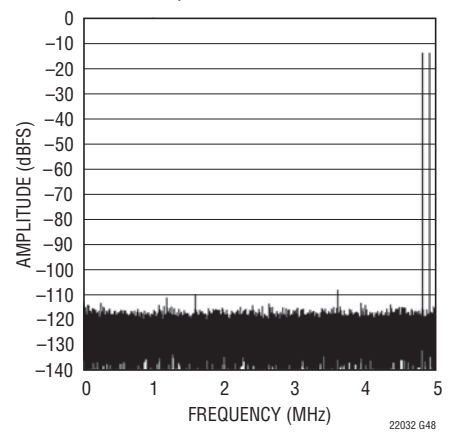
**LTC2203: 128K Point FFT,
 $f_{IN} = 5.1\text{MHz}$, -20dBFS , PGA = 0,
Internal Dither "On"**



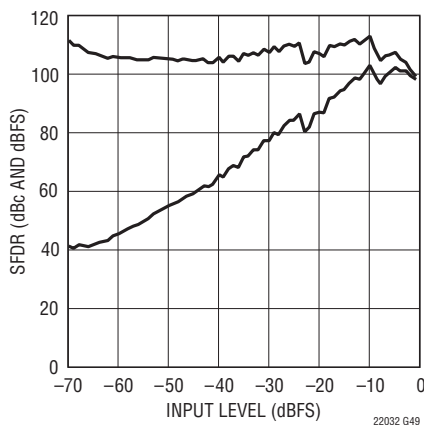
**LTC2202: 32K Point 2-Tone FFT,
 $f_{IN} = 5.1\text{MHz}$ and 15.2MHz ,
 -7dBFS , PGA = 0**



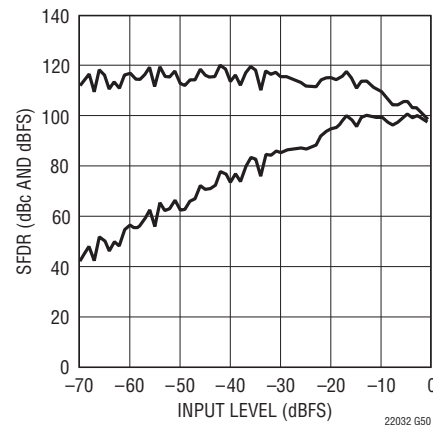
**LTC2202: 32K Point 2-Tone FFT,
 $f_{IN} = 5.1\text{MHz}$ and 15.2MHz ,
 -15dBFS , PGA = 0**



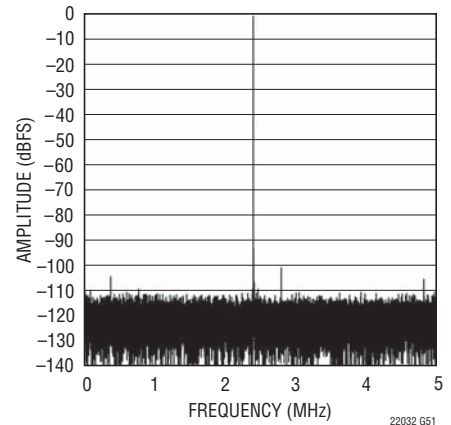
**LTC2202: SFDR vs Input Level,
 $f_{IN} = 5\text{MHz}$, PGA = 0, Dither "Off"**



**LTC2202: SFDR vs Input Level,
 $f_{IN} = 5\text{MHz}$, PGA = 0, Dither "On"**

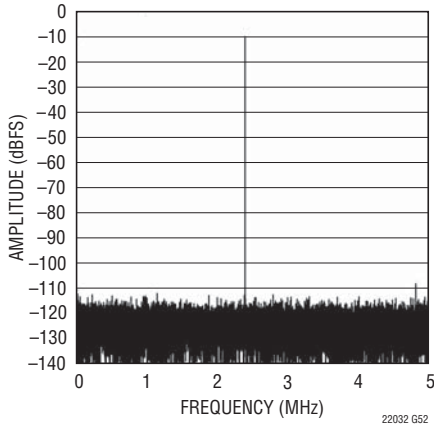


**LTC2202: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -1dBFS , PGA = 0**

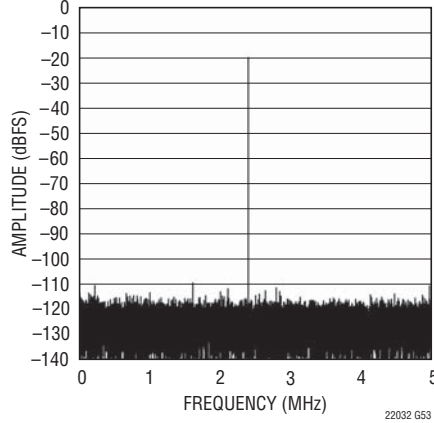


TYPICAL PERFORMANCE CHARACTERISTICS

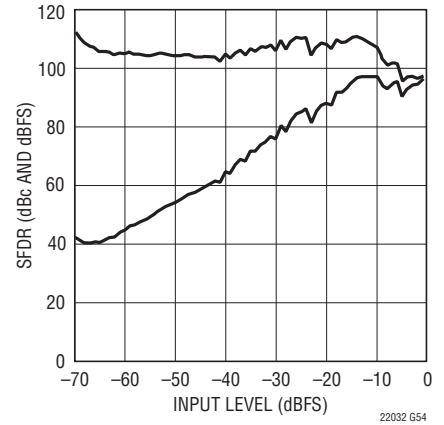
LTC2202: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -10dBFS , PGA = 0



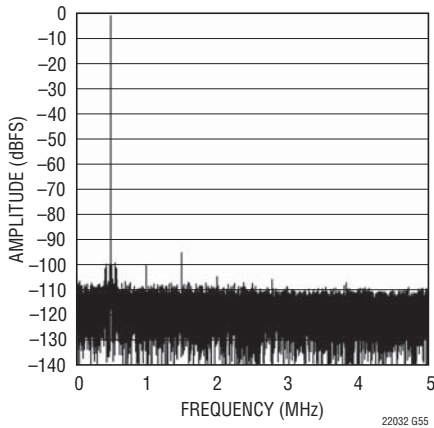
LTC2202: 32K Point FFT,
 $f_{IN} = 12.4\text{MHz}$, -20dBFS , PGA = 0



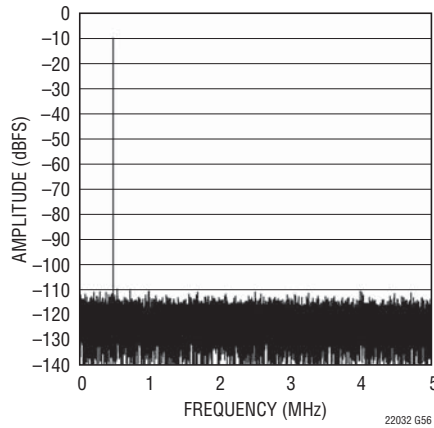
LTC2202: SFDR vs Input Level,
 $f_{IN} = 12.4\text{MHz}$, PGA = 0,
 Dither "Off"



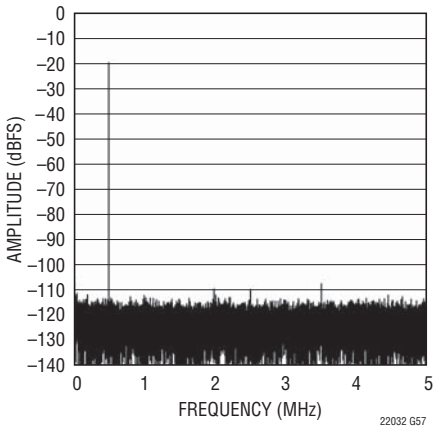
LTC2202: 32K Point FFT,
 $f_{IN} = 30.5\text{MHz}$, -1dBFS , PGA = 1



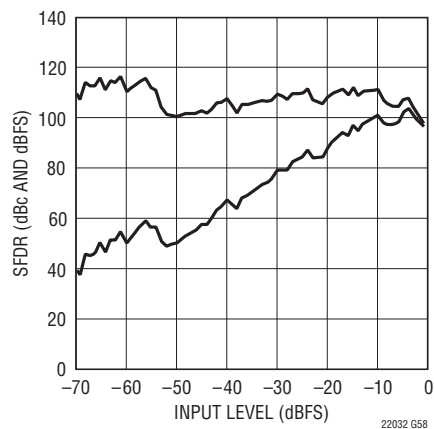
LTC2202: 32K Point FFT,
 $f_{IN} = 30.5\text{MHz}$, -10dBFS , PGA = 1



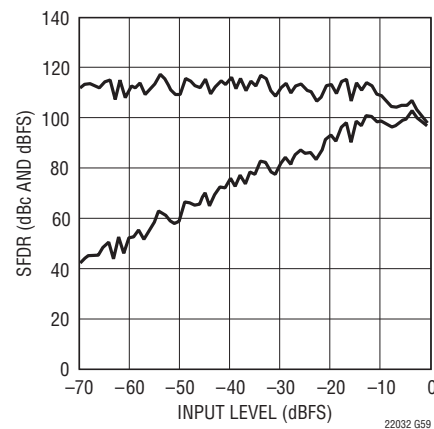
LTC2202: 32K Point FFT,
 $f_{IN} = 30.5\text{MHz}$, -20dBFS , PGA = 1



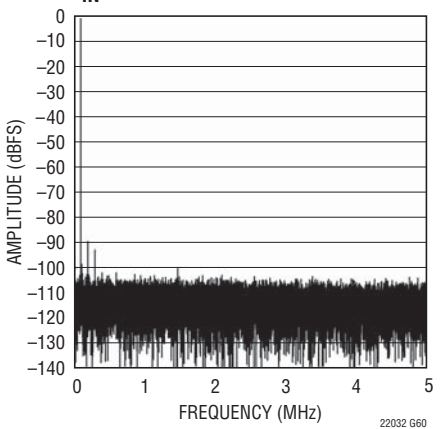
LTC2202: SFDR vs Input Level,
 $f_{IN} = 30.1\text{MHz}$, PGA = 0,
 Dither "Off"



LTC2202: SFDR vs Input Level,
 $f_{IN} = 30.1\text{MHz}$, PGA = 0,
 Dither "On"

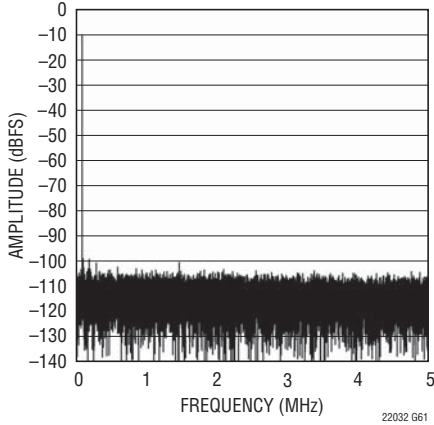


LTC2202: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -1dBFS , PGA = 1

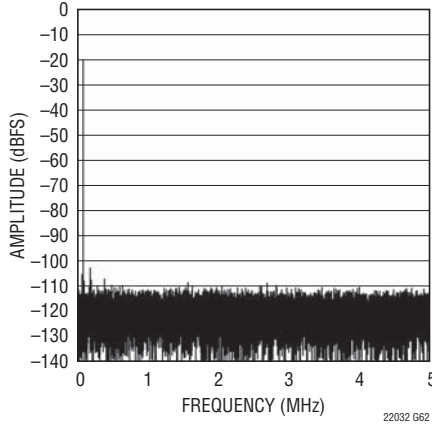


TYPICAL PERFORMANCE CHARACTERISTICS

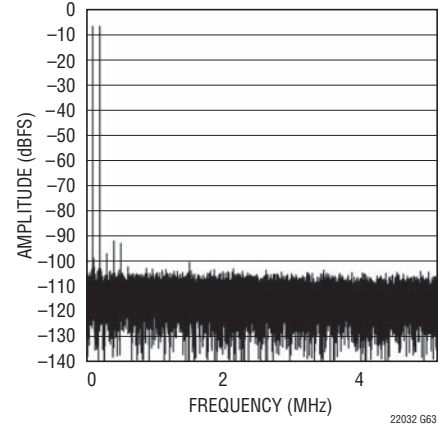
**LTC2202: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -10dBFS , $\text{PGA} = 1$**



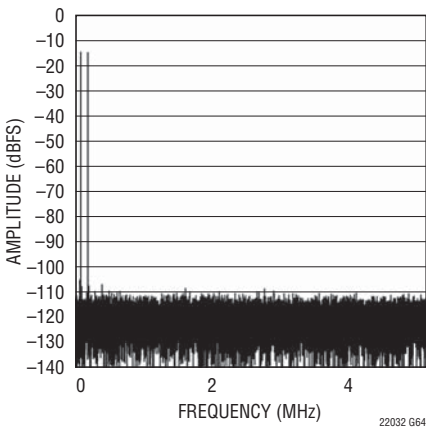
**LTC2202: 32K Point FFT,
 $f_{IN} = 70.1\text{MHz}$, -20dBFS , $\text{PGA} = 1$**



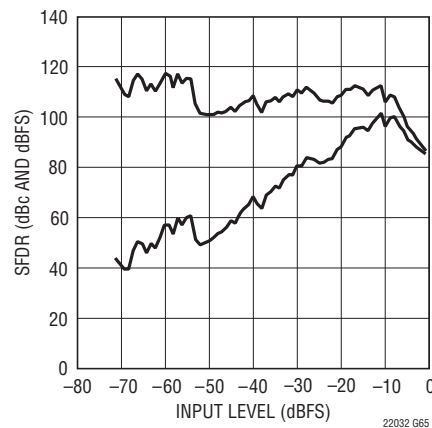
**LTC2202: 32K Point 2-Tone FFT,
 $f_{IN} = 60.2\text{MHz}$ and 70.1MHz ,
 -7dBFS , $\text{PGA} = 0$**



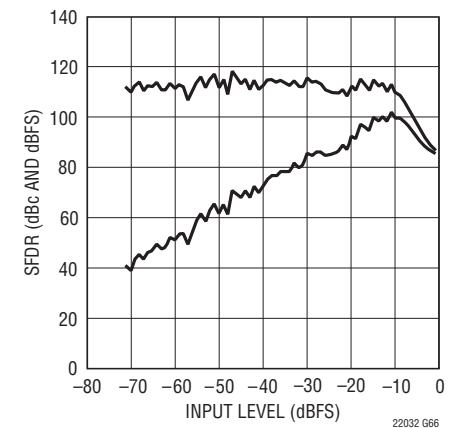
**LTC2202: 32K Point 2-Tone FFT,
 $f_{IN} = 60.2\text{MHz}$ and 70.1MHz ,
 -15dBFS , $\text{PGA} = 0$**



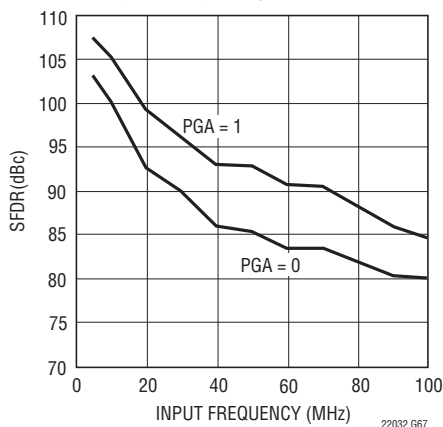
**LTC2202: SFDR vs Input Level,
 $f_{IN} = 70.1\text{MHz}$, $\text{PGA} = 0$,
Dither "Off"**



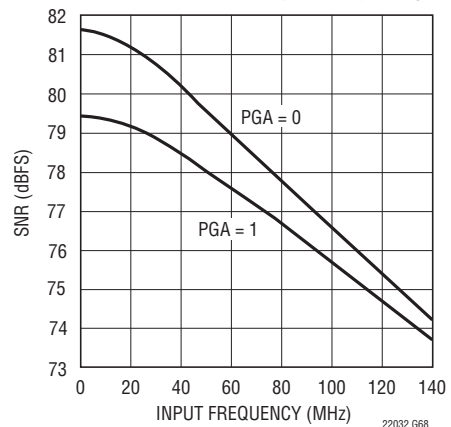
**LTC2202: SFDR vs Input Level,
 $f_{IN} = 70.1\text{MHz}$, $\text{PGA} = 0$,
Dither "On"**



**LTC2202: SFDR (HD2 or HD3)
vs Input Frequency**

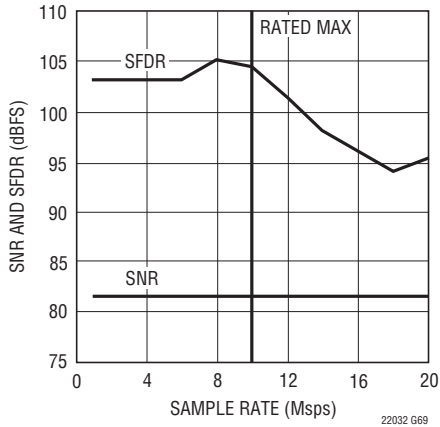
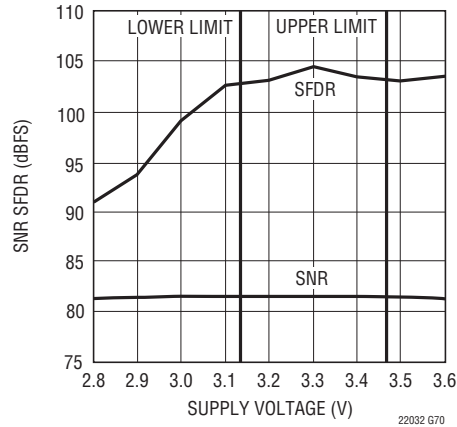
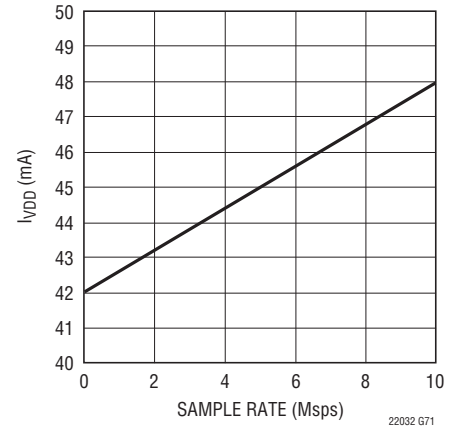


LTC2202: SNR vs Input Frequency

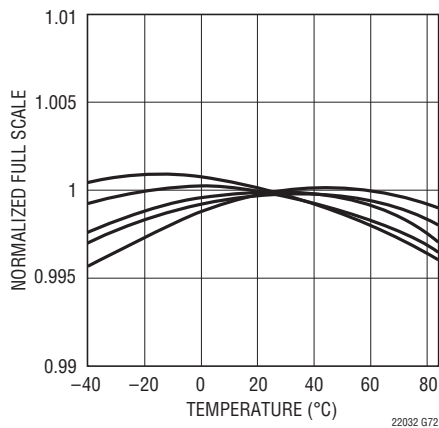


TYPICAL PERFORMANCE CHARACTERISTICS

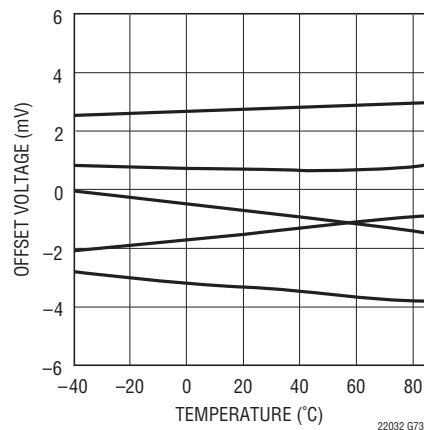
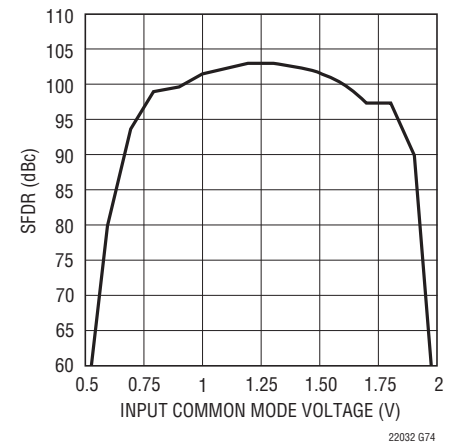
LTC2202: SNR and SFDR vs Sample Rate

LTC2202: SNR and SFDR vs Supply Voltage (V_{DD}), $f_{IN} = 5\text{MHz}$ LTC2202: I_{VDD} vs Sample Rate, 5MHz Sine Wave, -1dBFS

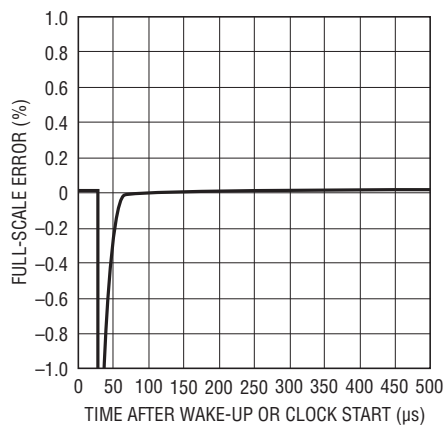
LTC2202: Normalized Full Scale vs Temperature, Internal Reference, 5 Units



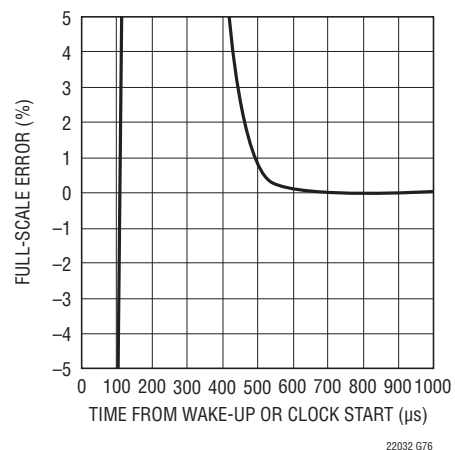
LTC2202: Offset Voltage vs Temperature, 5 Units

LTC2202: SFDR vs Input Common Mode Voltage, $f_{IN} = 5\text{MHz}$, -1dBFS, PGA = 0

Mid-Scale Settling After Wake Up from Shutdown or Starting Encode Clock



Full-Scale Settling After Wake Up from Shutdown or Starting Encode Clock



PIN FUNCTIONS

SENSE (Pin 1): Reference Mode Select and External Reference Input. Tie SENSE to V_{DD} with $1k\ \Omega$ or less to select the internal 2.5V bandgap reference. An external reference of 2.5V or 1.25V may be used; both reference values will set a full scale ADC range of 2.5V ($PGA = 0$).

V_{CM} (Pin 2): 1.25V Output. Optimum voltage for input common mode. Must be bypassed to ground with a minimum of $2.2\mu F$. Ceramic chip capacitors are recommended.

V_{DD} (Pins 3, 4, 12, 13, 14): 3.3V Analog Supply Pin. Bypass to GND with $0.1\mu F$ ceramic chip capacitors.

GND (Pins 5, 8, 9, 11, 15, 48, 49): ADC Power Ground.

A_{IN}^+ (Pin 6): Positive Differential Analog Input.

A_{IN}^- (Pin 7): Negative Differential Analog Input.

CLK (Pin 10): Clock Input. The hold phase of the sample-and-hold circuit begins on the falling edge. The output data may be latched on the rising edge of CLK.

SHDN (Pin 16): Power Shutdown Pin. SHDN = low results in normal operation. SHDN = high results in powered down analog circuitry and the digital outputs are placed in a high impedance state.

DITH (Pin 17): Internal Dither Enable Pin. DITH = low disables internal dither. DITH = high enables internal dither. Refer to Internal Dither section of this data sheet for details on dither operation.

D0-D15 (Pins 18-22, 26-28, 32-35 and 39-42): Digital Outputs. D15 is the MSB.

OGND (Pins 23, 31 and 38): Output Driver Ground.

OV_{DD} (Pins 24, 25, 36, 37): Positive Supply for the Output Drivers. Bypass to ground with $0.1\mu F$ capacitor.

CLKOUT⁻ (Pin 29): Data Valid Output. CLKOUT⁻ will toggle at the sample rate. Latch the data on the falling edge of CLKOUT⁻.

CLKOUT⁺ (Pin 30): Inverted Data Valid Output. CLKOUT⁺ will toggle at the sample rate. Latch the data on the rising edge of CLKOUT⁺.

OF (Pin 43): Over/Under Flow Digital Output. OF is high when an over or under flow has occurred.

\overline{OE} (Pin 44): Output Enable Pin. Low enables the digital output drivers. High puts digital outputs in Hi-Z state.

MODE (Pin 45): Output Format and Clock Duty Cycle Stabilizer Selection Pin. Connecting MODE to 0V selects offset binary output format and disables the clock duty cycle stabilizer. Connecting MODE to $1/3V_{DD}$ selects offset binary output format and enables the clock duty cycle stabilizer. Connecting MODE to $2/3V_{DD}$ selects 2's complement output format and enables the clock duty cycle stabilizer. Connecting MODE to V_{DD} selects 2's complement output format and disables the clock duty cycle stabilizer.

RAND (Pin 46): Digital Output Randomization Selection Pin. RAND low results in normal operation. RAND high selects D1-D15 to be EXCLUSIVE-ORed with D0 (the LSB). The output can be decoded by again applying an XOR operation between the LSB and all other bits. The mode of operation reduces the effects of digital output interference.

PGA (Pin 47): Programmable Gain Amplifier Control Pin. Low selects a front-end gain of 1, input range of $2.5V_{P-P}$. High selects a front-end gain of 1.5, input range of $1.667V_{P-P}$.

GND (Exposed Pad, Pin 49): ADC Power Ground. The exposed pad on the bottom of the package must be soldered to ground.



APPLICATIONS INFORMATION

DYNAMIC PERFORMANCE

Signal-to-Noise Plus Distortion Ratio

The signal-to-noise plus distortion ratio $[S/(N+D)]$ is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components at the ADC output. The output is band limited to frequencies above DC to below half the sampling frequency.

Signal-to-Noise Ratio

The signal-to-noise (SNR) is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components, except the first five harmonics.

Total Harmonic Distortion

Total harmonic distortion is the ratio of the RMS sum of all harmonics of the input signal to the fundamental itself. The out-of-band harmonics alias into the frequency band between DC and half the sampling frequency. THD is expressed as:

$$THD = -20\log\left(\sqrt{V_2^2 + V_3^2 + V_4^2 + \dots V_N^2}/V_1\right)$$

where V_1 is the RMS amplitude of the fundamental frequency and V_2 through V_N are the amplitudes of the second through n th harmonics.

Intermodulation Distortion

If the ADC input signal consists of more than one spectral component, the ADC transfer function nonlinearity can produce intermodulation distortion (IMD) in addition to THD. IMD is the change in one sinusoidal input caused by the presence of another sinusoidal input at a different frequency.

If two pure sine waves of frequencies f_a and f_b are applied to the ADC input, nonlinearities in the ADC transfer function can create distortion products at the sum and difference frequencies of $m f_a \pm n f_b$, where m and $n = 0, 1, 2, 3$, etc. For example, the 3rd order IMD terms include $(2f_a + f_b)$, $(f_a + 2f_b)$, $(2f_a - f_b)$ and $(f_a - 2f_b)$. The 3rd order IMD is defined as the ratio of the RMS value of either input tone to the RMS value of the largest 3rd order IMD product.

Spurious Free Dynamic Range (SFDR)

The ratio of the RMS input signal amplitude to the RMS value of the peak spurious spectral component expressed in dBc. SFDR may also be calculated relative to full scale and expressed in dBFS.

Full Power Bandwidth

The Full Power bandwidth is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3dB for a full scale input signal.

Aperture Delay Time

The time from when CLK reaches 0.45 of V_{DD} to the instant that the input signal is held by the sample-and-hold circuit.

Aperture Delay Jitter

The variation in the aperture delay time from conversion to conversion. This random variation will result in noise when sampling an AC input. The signal to noise ratio due to the jitter alone will be:

$$SNR_{JITTER} = -20\log(2\pi \cdot f_{IN} \cdot t_{JITTER})$$

APPLICATIONS INFORMATION

CONVERTER OPERATION

The LTC2203/LTC2202 are CMOS pipelined multistep converters with a front-end PGA. As shown in Figure 1, the converter has five pipelined ADC stages; a sampled analog input will result in a digitized value seven cycles later (see the Timing Diagram section). The analog input is differential for improved common mode noise immunity and to maximize the input range. Additionally, the differential input drive will reduce even order harmonics of the sample-and-hold circuit.

Each pipelined stage shown in Figure 1 contains an ADC, a reconstruction DAC and an interstage amplifier. In operation, the ADC quantizes the input to the stage and the quantized value is subtracted from the input by the DAC to produce a residue. The residue is amplified and output by the residue amplifier. Successive stages operate out of phase so that when odd stages are outputting their residue, the even stages are acquiring that residue and vice versa.

The phase of operation is determined by the state of the CLK input pin.

When CLK is high, the analog input is sampled differentially directly onto the input sample-and-hold capacitors, inside the “input S/H” shown in the block diagram. At the instant that CLK transitions from high to low, the voltage on the sample capacitors is held. While CLK is low, the held input voltage is buffered by the S/H amplifier which drives the first pipelined ADC stage. The first stage acquires the output of the S/H amplifier during the low phase of CLK. When CLK goes back high, the first stage produces its residue which is acquired by the second stage. At the same time, the input S/H goes back to acquiring the analog input. When CLK goes low, the second stage produces its residue which is acquired by the third stage. An identical process is repeated for the third and fourth stages, resulting in a fourth stage residue that is sent to the fifth stage for final evaluation.

Each ADC stage following the first has additional range to accommodate flash and amplifier offset errors. Results from all of the ADC stages are digitally delayed such that the results can be properly combined in the correction logic before being sent to the output buffer.

SAMPLE/HOLD OPERATION AND INPUT DRIVE

Sample/Hold Operation

Figure 2 shows an equivalent circuit for the LTC2203/LTC2202 CMOS differential sample and hold. The differential analog inputs are sampled directly onto sampling capacitors (C_{SAMPLE}) through NMOS transistors. The capacitors shown attached to each input ($C_{PARASITIC}$) are the summation of all other capacitance associated with each input.

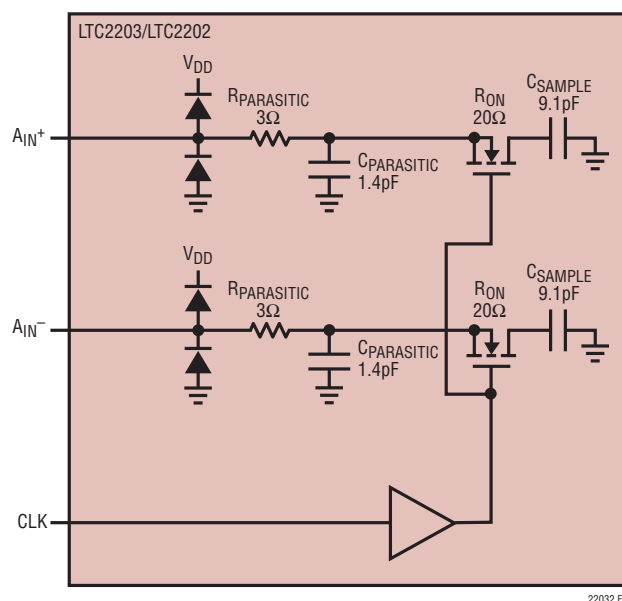


Figure 2. Equivalent Input Circuit

During the sample phase when CLK is high, the NMOS transistors connect the analog inputs to the sampling capacitors and they charge to, and track the differential input voltage. When CLK transitions from high to low, the sampled input voltage is held on the sampling capacitors. During the hold phase when CLK is high, the sampling capacitors are disconnected from the input and the held voltage is passed to the ADC core for processing. As CLK transitions from low to high, the inputs are reconnected to the sampling capacitors to acquire a new sample. Since the sampling capacitors still hold the previous sample, a charging glitch proportional to the change in voltage between samples will be seen at this time at the input of the converter. If the change between the last sample and

APPLICATIONS INFORMATION

the new sample is small, the charging glitch seen at the input will be small. If the input change is large, such as the change seen with input frequencies near Nyquist, then a larger charging glitch will be seen.

Common Mode Bias

The ADC sample-and-hold circuit requires differential drive to achieve specified performance. Each input may swing $\pm 0.625\text{V}$ for the 2.5V range ($\text{PGA} = 0$) or $\pm 0.417\text{V}$ for the 1.667V range ($\text{PGA} = 1$), around a common mode voltage of 1.25V. The V_{CM} output pin (Pin 3) is designed to provide the common mode bias level. V_{CM} can be tied directly to the center tap of a transformer to set the DC input level or as a reference level to an op amp differential driver circuit. The V_{CM} pin must be bypassed to ground close to the ADC with $2.2\mu\text{F}$ or greater.

Input Drive Impedance

As with all high performance, high speed ADCs the dynamic performance of the LTC2203/LTC2202 can be influenced by the input drive circuitry, particularly the second and third harmonics. Source impedance and input reactance can influence SFDR. At the rising edge of CLK the sample and hold circuit will connect the 9.1pF sampling capacitor to the input pin and start the sampling period. The sampling period ends when CLK falls, holding the sampled input on the sampling capacitor. Ideally, the input circuitry should be fast enough to fully charge the sampling capacitor during the sampling period $1/(2F_{\text{CLK}})$; however, this is not always possible and the incomplete settling may degrade the SFDR. The sampling glitch has been designed to be as linear as possible to minimize the effects of incomplete settling.

For the best performance it is recommended to have a source impedance of 100Ω or less for each input. The source impedance should be matched for the differential inputs. Poor matching will result in higher even order harmonics, especially the second.

INPUT DRIVE CIRCUITS

Figure 3 shows the LTC2203/LTC2202 being driven by an RF transformer with a center-tapped secondary. The secondary center tap is DC biased with V_{CM} , setting the ADC input signal at its optimum DC level. Figure 3 shows a 1:1 turns

ratio transformer. Other turns ratios can be used; however, as the turns ratio increases so does the impedance seen by the ADC. Source impedance greater than 50Ω can reduce the input bandwidth and increase high frequency distortion. A disadvantage of using a transformer is the loss of low frequency response. Most small RF transformers have poor performance at frequencies below 1MHz.

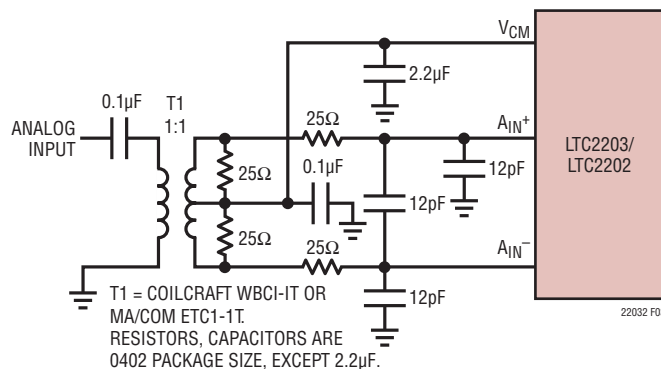


Figure 3. Single-Ended to Differential Conversion Using a Transformer. Recommended for Input Frequencies from 1MHz to 100MHz

Center-tapped transformers provide a convenient means of DC biasing the secondary; however, they often show poor balance at high input frequencies, resulting in large 2nd order harmonics.

Figure 4 shows transformer coupling using a transmission line balun transformer. This type of transformer has much better high frequency response and balance than flux coupled center tap transformers. Coupling capacitors are added at the ground and input primary terminals to allow the secondary terminals to be biased at 1.25V.

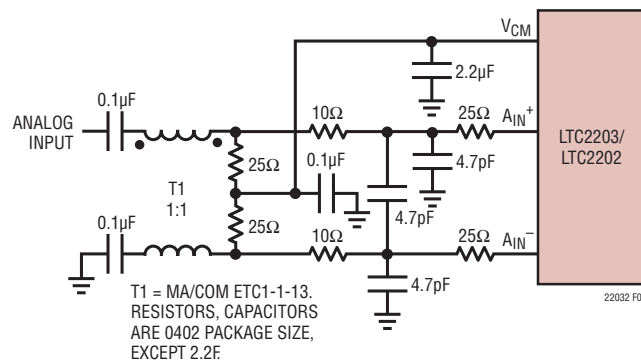


Figure 4. Using a Transmission Line Balun Transformer. Recommended for Input Frequencies from 50MHz to 250MHz

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Figure 5 demonstrates the use of an LTC1994 differential amplifier to convert a single ended input signal into a differential input signal. The advantage of this method is that it provides low frequency input response; however, the limited gain bandwidth of any op amp will limit the SFDR at high input frequencies.

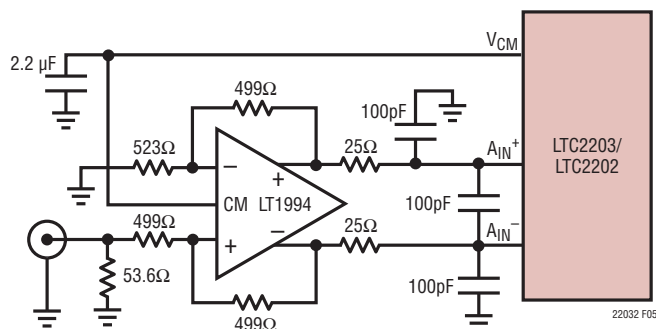


Figure 5. DC Coupled Input with Differential Amplifier

The 25Ω resistors and 12pF capacitor on the analog inputs serve two purposes: isolating the drive circuitry from the sample-and-hold charging glitches and limiting the wideband noise at the converter input.

Reference Operation

Figure 6 shows the LTC2203/LTC2202 reference circuitry consisting of a 2.5V bandgap reference, a programmable gain amplifier and control circuit. The LTC2203/LTC2202 has three modes of reference operation: Internal Reference, 1.25V external reference or 2.5V external reference. To use the internal reference, tie the SENSE pin to V_{DD} . To use the external reference, simply apply either a 1.25V or 2.5V reference voltage to the SENSE input pin. Both 1.25V and 2.5V applied to SENSE will result in a full scale range of 2.5V_{P-P} (PGA = 0). A 1.25V output, V_{CM} , is provided for a common mode bias for input drive circuitry. An external bypass capacitor is required for the V_{CM} output. This provides a high frequency low impedance path to ground for internal and external circuitry. This is also the compensation capacitor for the reference; it will not be stable without this capacitor. The minimum value required for stability is 2.2μF.

The internal programmable gain amplifier provides the internal reference voltage for the ADC. This amplifier has very stringent settling requirements and is not accessible for external use.

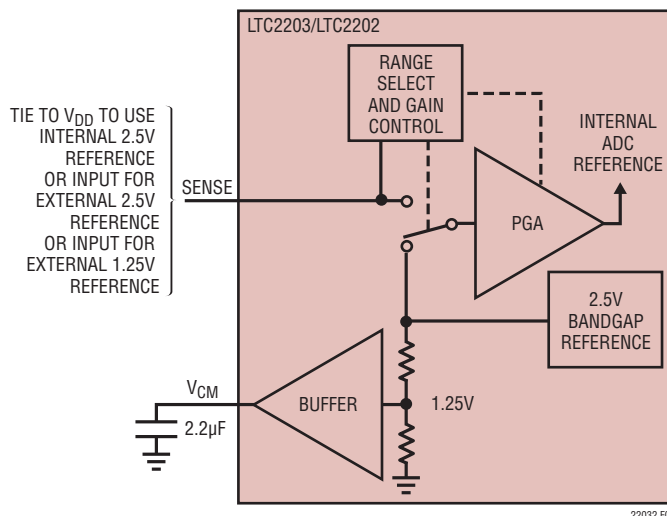


Figure 6. Reference Circuit

The SENSE pin can be driven $\pm 5\%$ around the nominal 2.5V or 1.25V external reference input. This adjustment range can be used to trim the ADC gain error or other system gain errors. When selecting the internal reference, the SENSE pin should be tied to V_{DD} as close to the converter as possible. If the sense pin is driven externally it should be bypassed to ground as close to the device as possible with at least a 1μF ceramic capacitor.

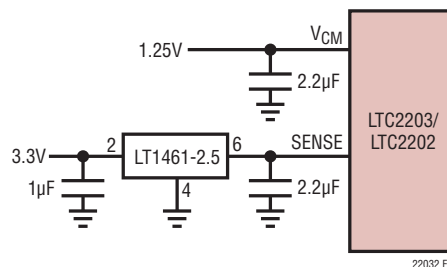


Figure 7. A 2.25V Range ADC with an External 2.5V Reference

APPLICATIONS INFORMATION

PGA Pin

The PGA pin selects between two gain settings for the ADC front-end. PGA = 0 selects an input range of $2.5V_{P-P}$; PGA = 1 selects an input range of $1.667V_{P-P}$. The $2.5V$ input range has the best SNR; however, the distortion will be higher for input frequencies above $100MHz$. For applications with high input frequencies, the low input range will have improved distortion; however, the SNR will be $2.4dB$ worse. See the Typical Performance Characteristics section.

Driving the Clock Input

The CLK input can be driven directly with a CMOS or TTL level signal. A sinusoidal clock can also be used along with a low-jitter squaring circuit before the CLK pin (Figure 8).

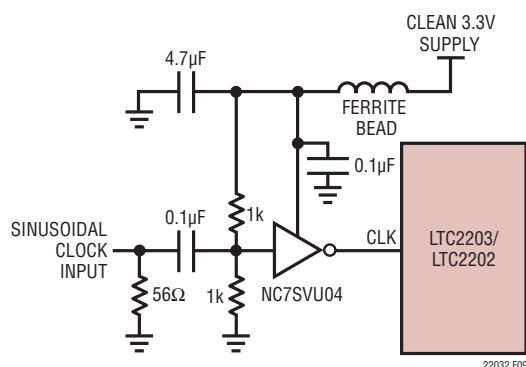


Figure 8. Sinusoidal Single-Ended CLK Drive

The noise performance of the LTC2203/2202 can depend on the clock signal quality as much as on the analog input. Any noise present on the clock signal will result in additional aperture jitter that will be RMS summed with the inherent ADC aperture jitter.

In applications where jitter is critical, such as when digitizing high input frequencies, use as large an amplitude as possible. It is also helpful to drive the CLK pin with a low-jitter high frequency source which has been divided down to the appropriate sample rate. If the ADC is clocked with a sinusoidal signal, filter the CLK signal to reduce wideband noise and distortion products generated by the source.

Maximum and Minimum Conversion Rates

The maximum conversion rate for the LTC2203 is 25Msps. The maximum conversion rate for the LTC2202 is 10Msps. For the ADC to operate properly the CLK signal should have a 50% ($\pm 5\%$) duty cycle. Each half cycle must have at least 18.9ns for the LTC2203 internal circuitry to have enough settling time for proper operation. For the LTC2202, each half cycle must be at least 40ns.

An on-chip clock duty cycle stabilizer may be activated if the input clock does not have a 50% duty cycle. This circuit uses the falling edge of CLK pin to sample the analog input. The rising edge of CLK is ignored and an internal rising edge is generated by a phase-locked loop. The input clock duty cycle can vary from 30% to 70% and the clock duty cycle stabilizer will maintain a constant 50% internal duty cycle. If the clock is turned off for a long period of time, the duty cycle stabilizer circuit will require one hundred clock cycles for the PLL to lock onto the input clock. To use the clock duty cycle stabilizer, the MODE pin must be connected to $1/3V_{DD}$ or $2/3V_{DD}$ using external resistors.

The lower limit of the LTC2203/LTC2202 sample rate is determined by droop of the sample and hold circuits. The pipelined architecture of this ADC relies on storing analog signals on small valued capacitors. Junction leakage will discharge the capacitors. The specified minimum operating frequency for the LTC2203/LTC2202 is 1Msps.

APPLICATIONS INFORMATION

DIGITAL OUTPUTS

Digital Output Buffers

Figure 9 shows an equivalent circuit for a single output buffer in CMOS Mode. Each buffer is powered by $0V_{DD}$ and $OGND$, isolated from the ADC power and ground. The additional N-channel transistor in the output driver allows operation down to low voltages. The internal resistor in series with the output makes the output appear as 50Ω to external circuitry and eliminates the need for external damping resistors.

As with all high speed/high resolution converters, the digital output loading can affect the performance. The digital outputs of the LTC2203/LTC2202 should drive a minimum capacitive load to avoid possible interaction between the digital outputs and sensitive input circuitry. The output should be buffered with a device such as a ALVCH16373 CMOS latch. For full speed operation the capacitive load should be kept under $10pF$. A resistor in series with the output may be used but is not required since the ADC has a series resistor of 43Ω on chip.

Lower $0V_{DD}$ voltages will also help reduce interference from the digital outputs.

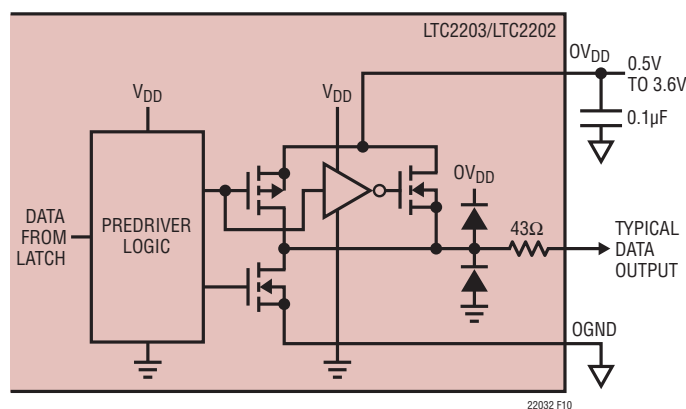


Figure 9. Equivalent Circuit for a Digital Output Buffer

Data Format

The LTC2203/LTC2202 parallel digital output can be selected for offset binary or 2's complement format. The format is selected with the MODE pin. This pin has a four level logic input, centered at 0, $1/3V_{DD}$, $2/3V_{DD}$ and V_{DD} . An external resistor divider can be used to set the $1/3V_{DD}$ and $2/3V_{DD}$ logic levels. Table 1 shows the logic states for the MODE pin.

Table 1. MODE Pin Function

MODE	OUTPUT FORMAT	CLOCK DUTY CYCLE STABILIZER
0(GND)	Offset Binary	Off
$1/3V_{DD}$	Offset Binary	On
$2/3V_{DD}$	2's Complement	On
V_{DD}	2's Complement	Off

Overflow Bit

An overflow output bit (OF) indicates when the converter is over-ranged or under-ranged. A logic high on the OF pin indicates an overflow or underflow.

Output Clock

The ADC has a delayed version of the CLK input available as a digital output. Both a noninverted version, $CLKOUT^+$ and an inverted version $CLKOUT^-$ are provided. The $CLKOUT^+/CLKOUT^-$ can be used to synchronize the converter data to the digital system. This is necessary when using a sinusoidal clock. Data can be latched on the rising edge of $CLKOUT^+$ or the falling edge of $CLKOUT^-$. $CLKOUT^+$ falls and $CLKOUT^-$ rises as the data outputs are updated.

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Digital Output Randomizer

Interference from the ADC digital outputs is sometimes unavoidable. Interference from the digital outputs may be from capacitive or inductive coupling or coupling through the ground plane. Even a tiny coupling factor can result in discernible unwanted tones in the ADC output spectrum. By randomizing the digital output before it is transmitted off chip, these unwanted tones can be randomized, trading a slight increase in the noise floor for a large reduction in unwanted tone amplitude.

The digital output is “Randomized” by applying an exclusive-OR logic operation between the LSB and all other data output bits. To decode, the reverse operation is applied; that is, an exclusive-OR operation is applied between the LSB and all other bits. The LSB, OF and CLKOUT output are not affected. The output Randomizer function is active when the RAND pin is high.

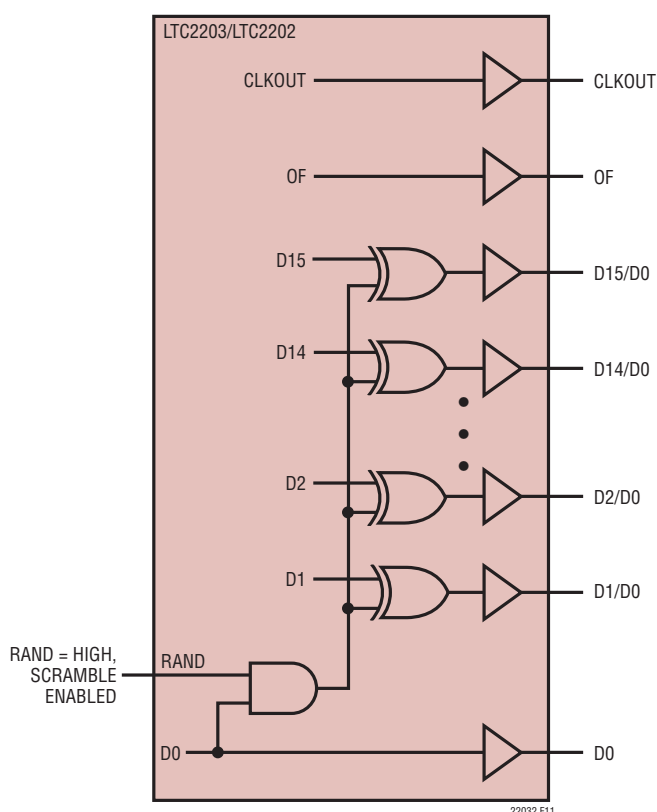


Figure 10. Functional Equivalent of Digital Output Randomizer

APPLICATIONS INFORMATION

Output Driver Power

Separate output power and ground pins allow the output drivers to be isolated from the analog circuitry. The power supply for the digital output buffers, OV_{DD} , should be tied to the same power supply as for the logic being driven. For example, if the converter is driving a DSP powered by a

1.8V supply, then OV_{DD} should be tied to that same 1.8V supply. In CMOS mode OV_{DD} can be powered with any logic voltage up to 3.6V. $OGND$ can be powered with any voltage from ground up to 1V and must be less than OV_{DD} . The logic outputs will swing between $OGND$ and OV_{DD} .

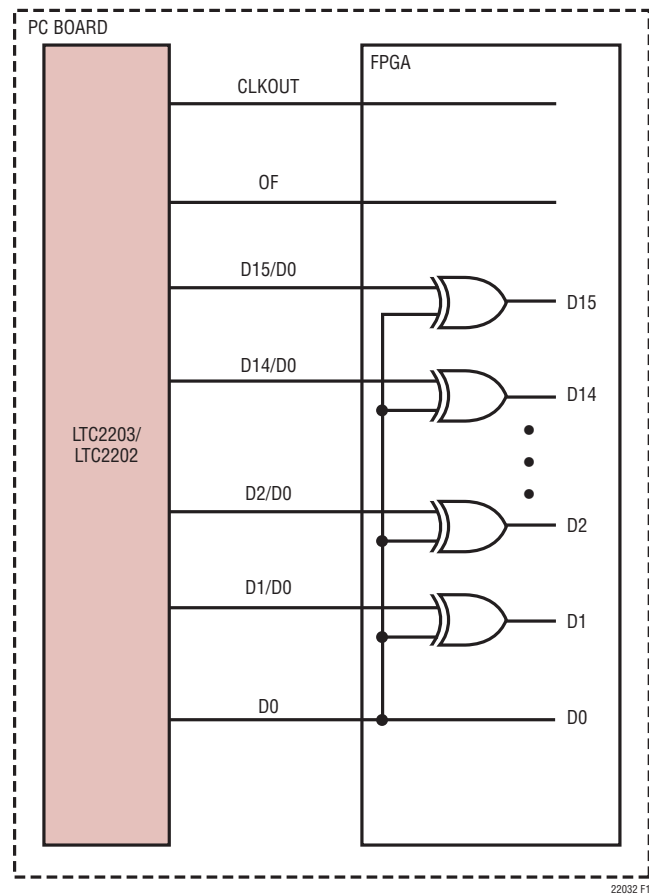


Figure 11. Descrambling a Scrambled Digital Output

APPLICATIONS INFORMATION

Internal Dither

The LTC2203/LTC2202 are 16-bit ADCs with very linear transfer functions; however, at low input levels even slight imperfections in the transfer function will result in unwanted tones. Small errors in the transfer function are usually a result of ADC element mismatches. An optional internal dither mode can be enabled to randomize the input's location on the ADC transfer curve, resulting in improved SFDR for low signal levels.

As shown in Figure 12, the output of the sample-and-hold amplifier is summed with the output of a dither DAC. The dither DAC is driven by a long sequence pseudo-random number generator; the random number fed to the dither DAC is also subtracted from the ADC result. If the dither DAC is precisely calibrated to the ADC, very little of the dither signal will be seen at the output. The dither signal that does leak through will appear as white noise. The dither DAC is calibrated to result in less than 0.5dB elevation in the noise floor of the ADC, as compared to the noise floor with dither off.

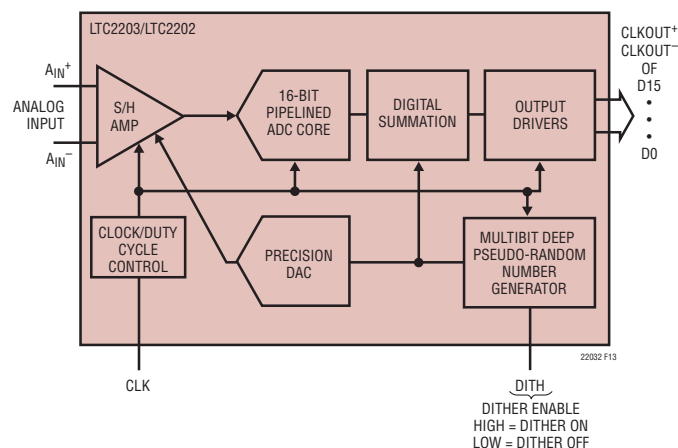


Figure 12. Functional Equivalent Block Diagram of Internal Dither Circuit

Grounding and Bypassing

The LTC2203/LTC2202 require a printed circuit board with a clean unbroken ground plane; a multilayer board with an internal ground plane is recommended. The pinout of the LTC2203/LTC2202 has been optimized for a flowthrough layout so that the interaction between inputs and digital outputs is minimized. Layout for the printed circuit board should ensure that digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital track alongside an analog signal track or underneath the ADC.

High quality ceramic bypass capacitors should be used at the V_{DD} , V_{CM} , and OV_{DD} pins. Bypass capacitors must be located as close to the pins as possible. The traces connecting the pins and bypass capacitors must be kept short and should be made as wide as possible.

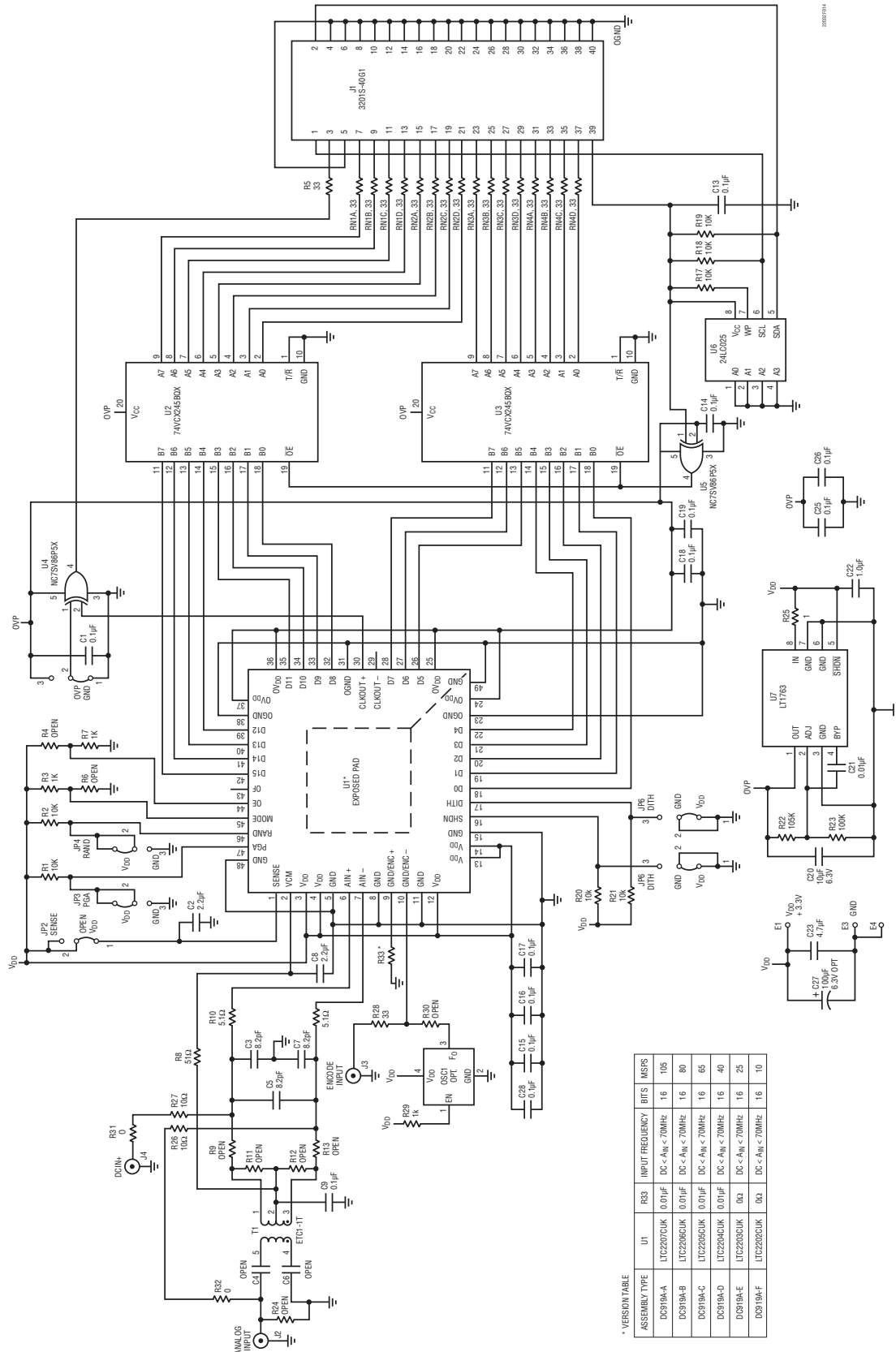
The LTC2203/LTC2202 differential inputs should run parallel and close to each other. The input traces should be as short as possible to minimize capacitance and to minimize noise pickup.

Heat Transfer

Most of the heat generated by the LTC2203/LTC2202 is transferred from the die through the bottom-side exposed pad. For good electrical and thermal performance, the exposed pad must be soldered to a large grounded pad on the PC board. It is critical that the exposed pad and all ground pins are connected to a ground plane of sufficient area with as many vias as possible.

APPLICATIONS INFORMATION

Evaluation Circuit Schematic of the LTC2203/LTC2202

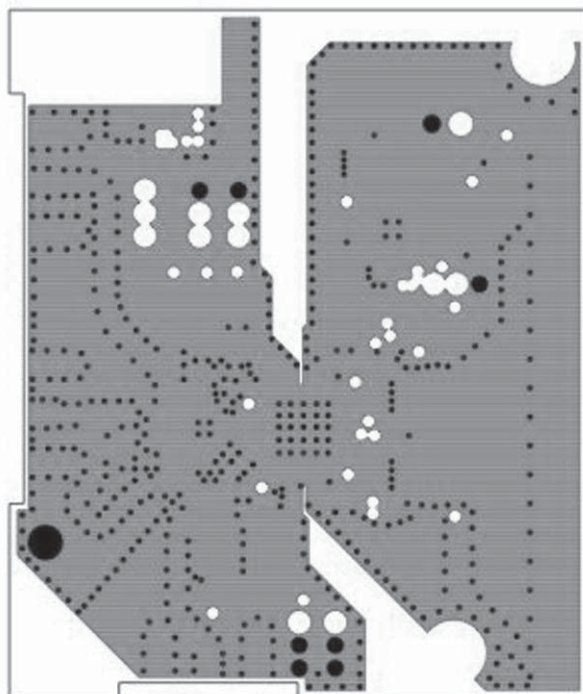


* VERSION TABLE

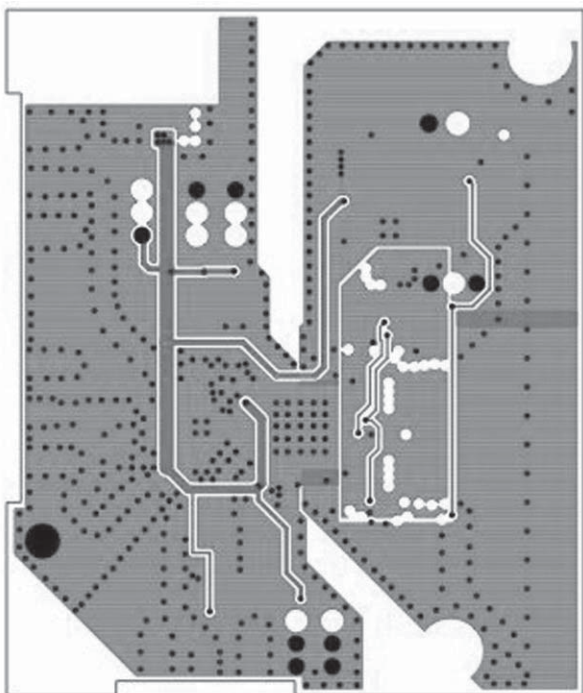
ASSEMBLY TYPE	U1	R33	INPUT FREQUENCY	BITS	MSPS
DS9194-A	LTC2207CLK	0.01µF	DC < A _{IN} < 70MHz	16	105
DS9194-B	LTC2206CLK	0.01µF	DC < A _{IN} < 70MHz	16	80
DS9194-C	LTC2205CLK	0.01µF	DC < A _{IN} < 70MHz	16	65
DS9194-D	LTC2204CLK	0.01µF	DC < A _{IN} < 70MHz	16	40
DS9194-E	LTC2203CLK	0.01µF	DC < A _{IN} < 70MHz	16	25
DS9194-F	LTC2202CLK	0.01µF	DC < A _{IN} < 70MHz	16	10

APPLICATIONS INFORMATION

Inner Layer 2

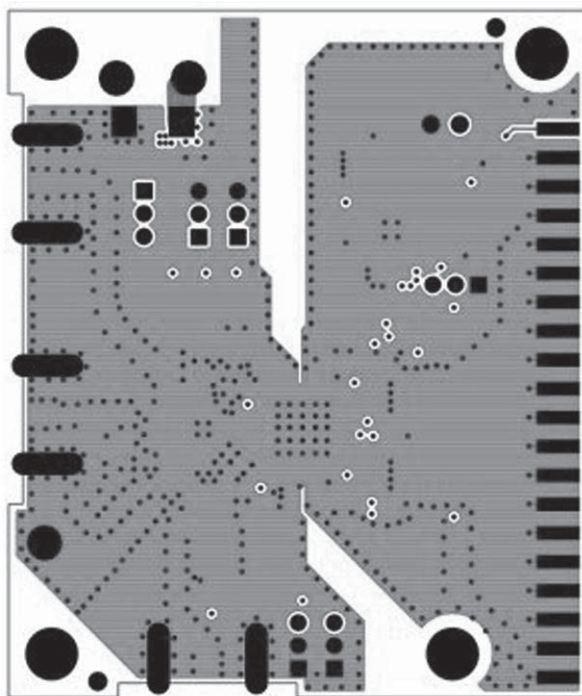


Inner Layer 3

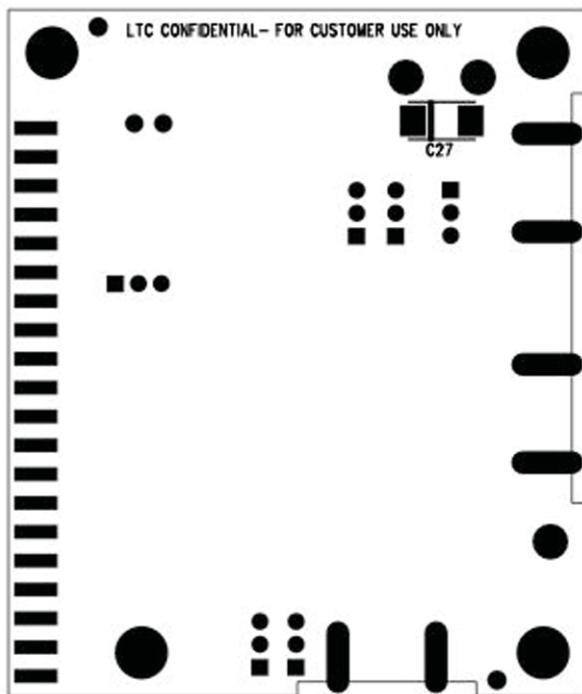


APPLICATIONS INFORMATION

Silkscreen Bottom Side



Silkscreen Bottom



22032fd

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1748	14-Bit, 80Msps ADC	76.3dB SNR, 90dB SFDR, 48-Pin TSSOP Package
LTC1750	14-Bit, 80Msps Wideband ADC	Up to 500MHz IF Undersampling, 90dB SFDR
LT1993-2	High Speed Differential Op Amp	800MHz BW, 70dBc Distortion at 70MHz, 6dB Gain
LT1994	Low Noise, Low Distortion Fully Differential Input/Output Amplifier/Driver	Low Distortion: -94dBc at 1MHz
LTC2204	16-Bit, 40Msps, 3.3V ADC	480mW, 79.1dB SNR, 100dB SFDR, 48-Pin QFN
LTC2205	16-Bit, 65Msps, 3.3V ADC	610mW, 79dB SNR, 100dB SFDR, 48-Pin QFN
LTC2206	16-Bit, 80Msps, 3.3V ADC	725mW, 77.9dB SNR, 100dB SFDR, 48-Pin QFN
LTC2207	16-Bit, 105Msps, 3.3V ADC	900mW, 77.9dB SNR, 100dB SFDR, 48-Pin QFN
LTC2208	16-Bit, 130Msps, 3.3V ADC, LVDS Outputs	1250mW, 77.1dB SNR, 100dB SFDR, 64-Pin QFN
LTC2220-1	12-Bit, 185Msps, 3.3V ADC, LVDS Outputs	910mW, 67.7dB SNR, 80dB SFDR, 64-Pin QFN
LTC2224	12-Bit, 135Msps, 3.3V ADC, High IF Sampling	630mW, 67.6dB SNR, 84dB SFDR, 48-Pin QFN
LTC2242-12	12-Bit, 250Msps, 2.5V ADC, LVDS Outputs	740mW, 65.4dB SNR, 84dB SFDR, 64-Pin QFN
LTC2255	14-Bit, 125Msps, 3V ADC, Lowest Power	395mW, 72.5dB SNR, 88dB SFDR, 32-Pin QFN
LTC2284	14-Bit, Dual, 105Msps, 3V ADC, Low Crosstalk	540mW, 72.4dB SNR, 88dB SFDR, 64-pin QFN
LT5512	DC-3GHz High Signal Level Downconverting Mixer	DC to 3GHz, 21dBm IIP3, Integrated LO Buffer
LT5514	Ultralow Distortion IF Amplifier/ADC Driver with Digitally Controlled Gain	450MHz to 1dB BW, 47dB OIP3, Digital Gain Control 10.5dB to 33dB in 1.5dB/Step
LT5515	1.5GHz to 2.5GHz Direct Conversion Quadrature Demodulator	High IIP3: 20dBm at 1.9GHz, Integrated LO Quadrature Generator
LT5516	800MHz to 1.5GHz Direct Conversion Quadrature Demodulator	High IIP3: 21.5dBm at 900MHz, Integrated LO Quadrature Generator
LT5517	40MHz to 900MHz Direct Conversion Quadrature Demodulator	High IIP3: 21dBm at 800MHz, Integrated LO Quadrature Generator
LT5522	600MHz to 2.7GHz High Linearity Downconverting Mixer	4.5V to 5.25V Supply, 25dBm IIP3 at 900MHz. NF = 12.5dB, 50Ω Single Ended RF and LO Ports



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.